## 8-bit Microcontrollers

**CMOS** 

## F<sup>2</sup>MC-8FX MB95110M Series

MB95117M/F114MS/F114NS/F114JS/F116MS/F116NS/F116JS/F116MAS/F116NAS MB95F118MS/F118NS/F118JS/F114MW/F114NW/F114JW/F116MAW/F116NAW MB95F116MW/F116NW/F116JW/F118MW/F118NW/F118JW/FV100D-103

#### **■ DESCRIPTION**

The MB95110M series is general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers contain a variety of peripheral functions.

Note: F2MC is the abbreviation of FUJITSU Flexible Microcontroller.

#### **■ FEATURES**

• F2MC-8FX CPU core

Instruction set optimized for controllers

- Multiplication and division instructions
- 16-bit arithmetic operations
- Bit test branch instruction
- · Bit manipulation instructions etc.
- Clock
  - · Main clock
  - Main PLL clock
  - Sub clock (for dual clock product)
  - Sub PLL clock (for dual clock product, except MB95F116MAW/F116NAW)

(Continued)

For the information for microcontroller supports, see the following web site.

This web site includes the "Customer Design Review Supplement" which provides the latest cautions on system development and the minimal requirements to be checked to prevent problems before the system development.

http://edevice.fujitsu.com/micom/en-support/



#### (Continued)

- Timer
  - 8/16-bit compound timer × 2 channels

Can be used to interval timer, PWC timer, PWM timer and input capture.

- 8/16-bit PPG × 2 channels
- 16-bit PPG × 1 channel
- Time-base timer × 1 channel
- Watch prescaler (for dual clock product) × 1 channel
- LIN-UART × 1 channel
  - · LIN function, clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable
  - Full duplex double buffer
- UART/SIO × 1 channel
  - Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable
  - Full duplex double buffer
- I<sup>2</sup>C × 1 channel

Built-in wake-up function

- External interrupt × 8 channels
  - Interrupt by edge detection (rising, falling, or both edges can be selected)
  - Can be used to recover from low-power consumption (standby) modes.
- 8/10-bit A/D converter × 8 channels

8-bit or 10-bit resolution can be selected

- Low-power consumption (standby) mode
  - Stop mode
  - Sleep mode
  - Watch mode (for dual clock product)
  - · Time-base timer mode
- I/O port
  - The number of maximum ports
    - Single clock product : 39 ports
    - Dual clock product : 37 ports
  - Configuration
    - General-purpose I/O ports (N-ch open drain): 2 ports
    - General-purpose I/O ports (CMOS) : Single clock product : 37 ports

      Dual clock product : 35 ports

• Programmable input voltage levels of port

Automotive input level / CMOS input level / hysteresis input level

- Dual operation Flash memory (Except MB95F116MAW/F116NAW/F116MAS/F116NAS)
  - Erase/Write and read can be executed in the different bank (Upper Bank/Lower Bank) at the same time.
- Flash memory security function

Protects the content of Flash memory (Flash memory device only)

### **■ MEMORIY LINEUP**

	Flash memory	RAM	
MB95F114MS/F114NS/F114JS	16 Kbytes	512 bytes	
MB95F114MW/F114NW/F114JW	To Royles	312 bytes	
MB95F116MS/F116NS/F116JS/ MB95F116MAS/F116NAS	- 32 Kbytes	1 Kbyte	
MB95F116MW/F116NW/F116JW/ MB95F116MAW/F116NAW	32 Naytes		
MB95F118MS/F118NS/F118JS	60 Kbytes	2 Kbytes	
MB95F118MW/F118NW/F118JW	ou ribytes	2 Noytes	

### **■ PRODUCT LINEUP**

Pa	Part number	MB95117M	MB95F114MS/ MB95F116MS/ MB95F116MAS/ MB95F118MS	MB95F114NS/ MB95F116NS/ MB95F116NAS/ MB95F118NS	MB95F114MW/ MB95F116MW/ MB95F116MAW/ MB95F118MW/	MB95F114NW/ MB95F116NW/ MB95F116NAW/ MB95F118NW	MB95F114JS/ MB95F116JS/ MB95F118JS	MB95F114JW/ MB95F116JW/ MB95F118JW	
Ту	pe	MASK ROM product							
RC	OM capacity*1	48 Kbytes			60 Kbyte	es (Max)			
R/	AM capacity*1				2 Kbytes (Max	x)			
Re	eset output	Yes/No		Y	'es		N	0	
*2	Clock system	Selectable single/dual clock*3	Single	Single clock Dual clock				Dual clock	
Option*2	Low voltage detection reset	Yes / No	No	Yes	No	Yes	Ye	es	
	Clock supervisor	Yes / No		1	No		Ye	es	
CPU functions  Number of basic instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, and 16 bits Minimum instruction execution time : 61.5 ns (at machine clock frequency Interrupt processing time : 0.6 μs (at machine clock frequency									
	General purpose I/O ports	urpose  • Dual clock product : 37 ports (N-ch open drain : 2 ports, CMOS : 35 ports)  Programmable input voltage levels of port :					3 : 35 ports)		
Time-base timer Interrupt cycle: 0.5 ms, 2.1 ms, 8.2 ms, 32.8 ms (at main oscillation clock 4 Minus)						n clock 4 MHz	)		
unctions	Watchdog timer	Reset generated cycle At main oscillation clock 10 MHz At sub oscillation clock 32.768 kHz (for dual clock product) : Min 105 ms							
al fu	Wild register	Capable of	f replacing 3 b	ytes of ROM	data				
Peripheral fu	I <sup>2</sup> C (1 channel)	Bus error f Detecting to Start cond	aster/slave sending and receiving as error function and arbitration function attecting transmitting direction function art condition repeated generation and detection functions ailt-in wake-up function						
Data transfer capable in UART/SIO Full duplex double buffer, variable data length (5/6/7/8-bit), built-in baud rate generator (1 channel) NRZ type transfer format, error detected function LSB-first or MSB-first can be selected. Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable						able			

#### (Continued)

	Part number	MB95117M			MB95F114MW/ MB95F116MW/ MB95F116MAW/		MB95F114JS/ MB95F116JS/ MB95F118JS	MB95F114JW/ MB95F116JW/ MB95F118JW
Pa	LIN-UART (1 channel)	Dedicated reload timer allowing a wide range of communication speeds to be set.  Full duplex double buffer.  Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable.  LIN functions available as the LIN master or LIN slave.						
	8/10-bit A/D converter (8 channels)	8-bit or 10-	bit resolution	can be selecte	ed.			
tions	8/16-bit compound timer (2 channels)	compound imer × 1 channel".  Built-in timer function, PWC function, PWM function, capture function, and square wave						
Peripheral functions	PWM mode or one-shot mode can be selected. Counter operating clock : 8 selectable clock sources Support for external trigger start							
Periph	8/16-bit PPG (2 channels) Each channel of the PPG can be used as "8-bit PPG × 2 channels" or "16-bit PPG × 1 channels" Counter operating clock : Eight selectable clock sources						×1 channel".	
	Watch counter (for dual clock product)	Counter va	lue can be se	t from 0 to 63	es (125 ms, 25 (Capable of co etting counter	ounting for 1m		
	Watch prescaler (for dual clock product) (1 channel)	clock 4 selectable interval times (125 ms, 250 ms, 500 ms, or 1 s)						
	External interrupt by edge detection (rising, falling, or both edges can be selected.)  (8 channels)  Interrupt by edge detection (rising, falling, or both edges can be selected.)							
Supports automatic programming, Embedded Algorithm Write/Erase/Erase-Suspend/Resume commands A flag indicating completion of the algorithm Number of write/erase cycles (Min): 10000 times  Plash memory Data retention time: 20 years Erase can be performed on each block Block protection with external programming voltage Dual operation Flash memory (Except MB95F116MAW/F116NAW/F116MAS/F116Flash Security Feature for protecting the content of the Flash				16NAS)				
Sta	andby mode	Sleep, stop	, watch (for d	ual clock prod	uct) , and time	-base timer		

<sup>\*1 :</sup> For ROM capacitance and RAM capacitance, refer to "■ MEMORY LINEUP".

Note: Part number of the evaluation products in MB95110M series is MB95FV100D-103. When using it, the MCU board (MB2146-303A-E) is required.

<sup>\*2 :</sup> When the MASK ROM is ordered, please select yes/no for the clock mode, low voltage detection, clock supervisor and reset output.

<sup>\*3:</sup> Specify clock mode when ordering MASK ROM.

#### ■ OSCILLATION STABILIZATION WAIT TIME

The initial value of the main clock oscillation stabilization wait time is fixed to the maximum value. The maximum value is shown as follows.

Oscillation stabilization wait time	Remarks
(2 <sup>14</sup> –2) /F <sub>CH</sub>	Approx. 4.10 ms (at main oscillation clock 4 MHz)

#### ■ PACKAGES AND CORRESPONDING PRODUCTS

Part number Parameter	MB95117M	MB95F114MS/F114NS MB95F114JS MB95F116MS/F116NS MB95F116MAS/ MB95F116NAS MB95F116JS MB95F118MS/F118NS MB95F118JS	MB95F114MW/F114NW MB95F114JW MB95F116MW/F116NW MB95F116MAW/ MB95F116NAW MB95F116JW MB95F118MW/F118NW MB95F118JW	MB95FV100D-103
FPT-52P-M01	0	$\circ$	0	×
BGA-224P-M08				

: Available: Unavailable

#### ■ DIFFERENCES AMONG PRODUCTS AND NOTES ON SELECTING PRODUCTS

#### Notes on Using Evaluation Products

The Evaluation product has not only the functions of the MB95110M series but also those of other products to support software development for multiple series and models of the F<sup>2</sup>MC-8FX family. The I/O addresses for peripheral resources not used by the MB95110M series are therefore access-barred. Read/write access to these access-barred addresses may cause peripheral resources supposed to be unused to operate, resulting in unexpected malfunctions of hardware or software.

Particularly, do not use word access to odd numbered byte address in the prohibited areas (If these access are used, the address may be read or write unexpectedly).

Also, as the read values of prohibited addresses on the evaluation product are different to the values on the Flash memory and MASK ROM products, do not use these values in the program.

The functions corresponding to certain bits in single-byte registers may not be supported on some MASK ROM products and Flash memory products. However, reading or writing to these bits will not cause malfunction of the hardware. Also, as the evaluation, Flash memory products are designed to have identical software operation, no particular precautions are required.

#### Difference of Memory Spaces

If the amount of memory on the Evaluation product is different from that of the Flash memory or MASK ROM product, carefully check the difference in the amount of memory from the model to be actually used when developing software.

For details of memory space, refer to "■ CPU CORE".

#### Current Consumption

- The current consumption of Flash memory product is typically greater than for MASK ROM product.
- For details of current consumption, refer to "■ ELECTRICAL CHARACTERISTICS".

#### Package

For details of information on each package, refer to "■ PACKAGE AND CORRESPONDING PRODUCTS" and "■ PACKAGE DIMENSION".

#### Operating Voltage

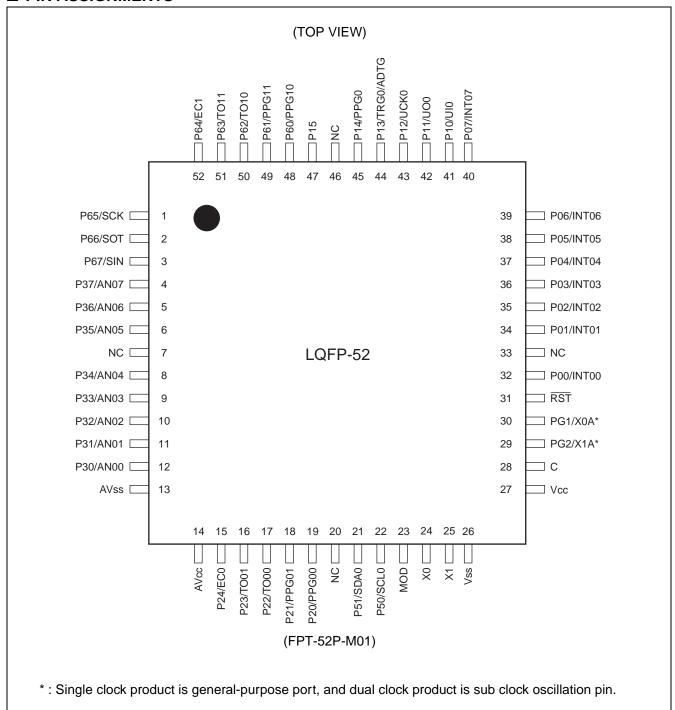
The operating voltage are different among the Evaluation, Flash memory, and MASK ROM products.

For details of operating voltage, refer to "■ ELECTRICAL CHARACTERISTICS"

#### • Difference between RST and MOD Pins

A pull-down resistor is provided for the MOD pin of the MASK ROM product.

#### **■ PIN ASSIGNMENTS**



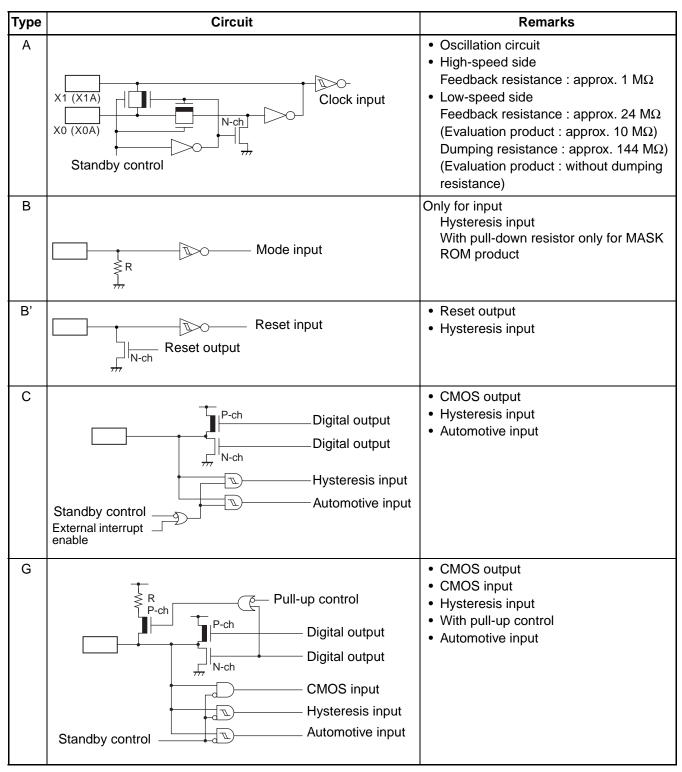
### **■ PIN DESCRIPTION**

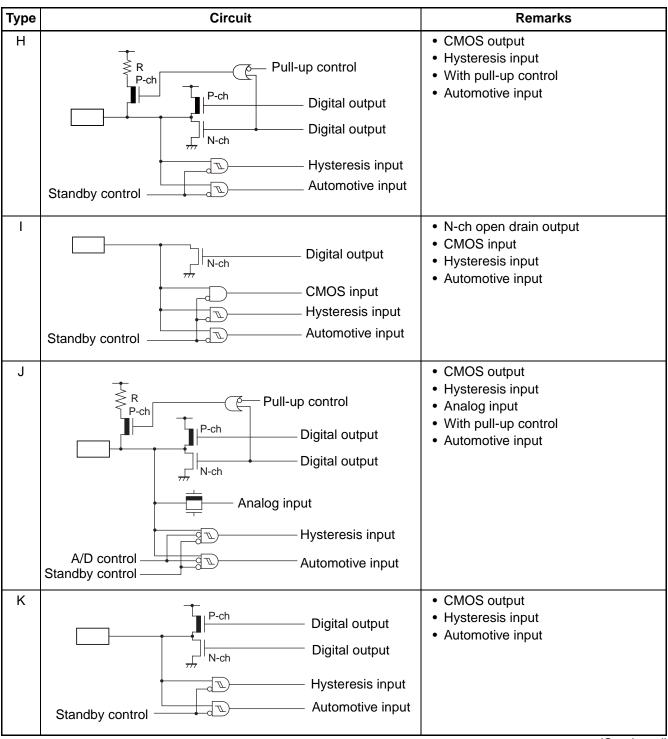
Pin no.	Pin name	I/O Circuit type*	Function	
1	P65/SCK	К	General-purpose I/O port. The pin is shared with LIN-UART clock I/O.	
2	P66/SOT		General-purpose I/O port. The pin is shared with LIN-UART data output.	
3	P67/SIN	L	General-purpose I/O port. The pin is shared with LIN-UART data input.	
4	P37/AN07			
5	P36/AN06			
6	P35/AN05			
8	P34/AN04		General-purpose I/O port.	
9	P33/AN03	J	The pins are shared with A/D converter analog input.	
10	P32/AN02			
11	P31/AN01			
12	P30/AN00			
13	AVss	_	A/D converter power supply pin (GND)	
14	AVcc	_	A/D converter power supply pin	
15	P24/EC0		General-purpose I/O port. The pin is shared with 8/16-bit compound timer ch.0 clock input.	
16	P23/TO01	Н	General-purpose I/O port.	
17	P22/TO00		1 H	The pins are shared with 8/16-bit compound timer ch.0 output.
18	P21/PPG01			General-purpose I/O port.
19	P20/PPG00		The pins are shared with 8/16-bit PPG ch.0 output.	
21	P51/SDA0		General-purpose I/O port. The pin is shared with I <sup>2</sup> C ch.0 data I/O.	
22	P50/SCL0	'	General-purpose I/O port. The pin is shared with I <sup>2</sup> C ch.0 clock I/O.	
23	MOD	В	Operating mode designation pin	
24	X0	۸	Main clock oscillation input pin	
25	X1	A	Main clock oscillation I/O pin	
26	Vss	_	Power supply pin (GND)	
27	Vcc	_	Power supply pin	
28	С	_	Capacitor connection pin	
29	PG2/X1A	H/A	Single clock product is general-purpose port (PG2).  Dual clock product is sub clock I/O oscillation pin (32 kHz).	
30	PG1/X0A	11/73	Single clock product is general-purpose port (PG1). Dual clock product is sub clock input oscillation pin (32 kHz).	
31	RST	B'	Reset pin	

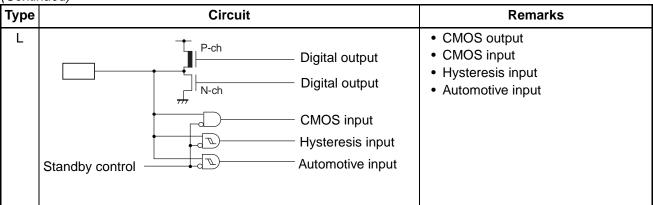
Pin no.	Pin name	I/O Circuit type*	Function
32	P00/INT00		
34	P01/INT01		
35	P02/INT02		
36	P03/INT03	С	General-purpose I/O port.
37	P04/INT04	C	The pins are shared with external interrupt input. Large current port.
38	P05/INT05		
39	P06/INT06		
40	P07/INT07		
41	P10/UI0	G	General-purpose I/O port. The pin is shared with UART/SIO ch.0 data input.
42	P11/UO0		General-purpose I/O port. The pin is shared with UART/SIO ch.0 data output.
43	P12/UCK0		General-purpose I/O port. The pin is shared with UART/SIO ch.0 clock I/O.
44	P13/TRG0/ ADTG	н	General-purpose I/O port. The pin is shared with 16-bit PPG ch.0 trigger input (TRG0) and A/D trigger input (ADTG).
45	P14/PPG0		General-purpose I/O port. The pin is shared with 16-bit PPG ch.0 output.
47	P15		General-purpose I/O port.
48	P60/PPG10		General-purpose I/O port.
49	P61/PPG11		The pins are shared with 8/16-bit PPG ch.1 output.
50	P62/TO10	K	General-purpose I/O port.
51	P63/TO11	.`	The pins are shared with 8/16-bit compound timer ch.1 output.
52	P64/EC1		General-purpose I/O port. The pin is shared with 8/16-bit compound timer ch.1 clock input.
7, 20, 33, 46	NC		Internally connected pins. Be sure to leave them open.

<sup>\*:</sup> For the I/O circuit type, refer to "■ I/O CIRCUIT TYPE"

#### **■ I/O CIRCUIT TYPE**







#### HANDLING DEVICES

#### Preventing Latch-up

Care must be taken to ensure that maximum voltage ratings are not exceeded when they are used.

Latch-up may occur on CMOS ICs if voltage higher than  $V_{\text{CC}}$  or lower than  $V_{\text{SS}}$  is applied to input and output pins other than medium- and high-withstand voltage pins or if higher than the rating voltage is applied between  $V_{\text{CC}}$  pin and  $V_{\text{SS}}$  pin.

When latch-up occurs, power supply current increases rapidly and might thermally damage elements.

Also, take care to prevent the analog power supply voltage (AVcc) and analog input voltage from exceeding the digital power supply voltage (Vcc) when the analog system power supply is turned on or off.

#### Stable Supply Voltage

Supply voltage should be stabilized.

A sudden change in power-supply voltage may cause a malfunction even within the guaranteed operating range of the Vcc power-supply voltage.

For stabilization, in principle, keep the variation in Vcc ripple (p-p value) in a commercial frequency range (50/60 Hz) not to exceed 10% of the standard Vcc value and suppress the voltage variation so that the transient variation rate does not exceed 0.1 V/ms during a momentary change such as when the power supply is switched.

#### Precautions for Use of External Clock

Even when an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from sub clock mode or stop mode.

#### Serial communication

There is a possibility to receive wrong data due to noise or other causes on the serial communication.

Therefore, design a printed circuit board so as to avoid noise.

Consider receiving of wrong data when designing the system. For example apply a checksum and retransmit the data if an error occurs.

#### **PIN CONNECTION**

#### Treatment of Unused Pin

Leaving unused input pins unconnected can cause abnormal operation or latch-up, leaving to permanent damage. Unused input pins should always be pulled up or down through resistance of at least  $2 \text{ k}\Omega$ . Any unused input/output pins may be set to output mode and left open, or set to input mode and treated the same as unused input pins. If there is unused output pin, make it open.

#### • Treatment of Power Supply Pins on A/D Converter

Connect to be AVcc = Vcc and AVss = Vss even if the A/D converter is not in use.

Noise riding on the AVcc pin may cause accuracy degradation. So, connect approx. 0.1  $\mu$ F ceramic capacitor as a bypass capacitor between AVcc and AVss pins in the vicinity of this device.

#### Power Supply Pins

In products with multiple Vcc or Vss pins, the pins of the same potential are internally connected in the device to avoid abnormal operations including latch-up. However, you must connect the pins to external power supply and a ground line to lower the electro-magnetic emission level, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total output current rating.

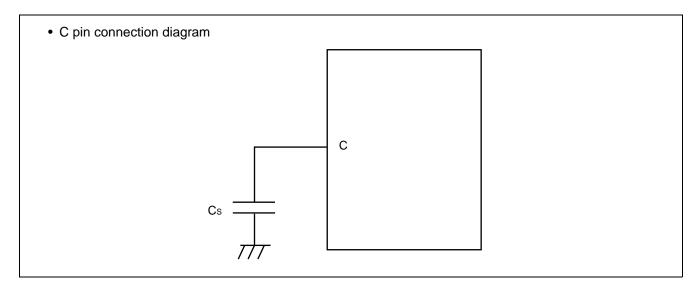
Moreover, connect the current supply source with the  $V_{\text{CC}}$  and  $V_{\text{SS}}$  pins of this device at the low impedance. It is also advisable to connect a ceramic bypass capacitor of approximately 0.1  $\mu\text{F}$  between  $V_{\text{CC}}$  and  $V_{\text{SS}}$  pins near this device.

#### • Mode Pin (MOD)

Connect the MOD pin directly to Vcc or Vss pins.

To prevent the device unintentionally entering test mode due to noise, lay out the printed circuit board so as to minimize the distance from the MOD pin to Vcc or Vss pins and to provide a low-impedance connection.

Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. A bypass capacitor of  $V_{CC}$  pin must have a capacitance value higher than  $C_S$ . For connection of smoothing capacitor  $C_S$ , refer to the diagram below.



#### • NC Pins

Any pins marked "NC" (not connected) must be left open.

#### Analog Power Supply

Always set the same potential to AVcc and Vcc. When Vcc > AVcc, the current may flow through the AN00 to AN07 pins.

## ■ PROGRAMMING FLASH MEMORY MICROCONTROLLERS USING PARALLEL PROGRAMMER

#### • Supported Parallel Programmers and Adapters

The following table lists supported parallel programmers and adapters.

Package	Applicable adapter model	Parallel programmers
FPT-52P-M01	TEF110-95118PMC	AF9708 (Ver 02.35G or more) AF9709/B (Ver 02.35G or more) AF9723+AF9834 (Ver 02.08E or more)

Note: For information on applicable adapter models and parallel programmers, contact the following: Flash Support Group, Inc. TEL: +81-53-428-8380

#### • Sector Configuration

The individual sectors of Flash memory correspond to addresses used for CPU access and programming by the parallel programmer as follows:

Flash memory	CPU address	Programmer address*	
A1 (4 Kbytes)	1000н	71000 <sub>H</sub>	
( 2) 22 2)	1FFF <sub>H</sub>	71FFF <sub>H</sub>	
SA2 (4Kbytes)	2000н	72000 <sub>H</sub>	Lower bank
SAZ (HABYICO)	2FFFн	72FFFн	OWel
200 (4 Khytoo)	3000н	73000H	
SA3 (4 Kbytes)	3FFFн	73FFFн	7
	4000н	74000н	
A4 (16 Kbytes)	7555	7755	1 }
	<u>7</u> FF <sub>H</sub> 8000н	<u>77FFF</u> н	
A5 (16 Kbytes)	ООООН	70000H	
, , ,	BFFF <sub>H</sub>	7BFFFн	
2AC (A Kh. +a-a)	С000н	7C000H	ᆂ
SA6 (4 Kbytes)	СFFFн	7CFFFн	Upper bank
	<u>Сггн</u> D000н	<u>/Сгггн</u> 7D000н	Je
SA7 (4 Kbytes)	Dooon	7 500011	A
	DFFFH	7DFFFн	
	Е000н	7 <u>Е</u> 000н	
SA8 (4 Kbytes)			
	EFFFH	7EFFF <sub>H</sub>	
SA9 (4 Kbytes)	<b>F</b> 000н	7F000н	
DAG (4 Noyles)	FFFF <sub>H</sub>	7FFFF <sub>H</sub>	₹ /

<sup>\* :</sup> Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.

These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

#### • Programming Method

- 1) Set the type code of the parallel programmer to "17222".
- 2) Load program data to programmer addresses 71000H to 7FFFFH.

#### 3) Programmed by parallel programmer

• MB95F116MS/F116NS/F116JS/F116MW/F116NW/F116JV	/ (32	Khytes)
	<b>V</b> (UZ	INDYIGO

Flash memory	CPU address	Programmer address*
SA5 (16 Kbytes)	8000 <sub>H</sub>	78000 <sub>H</sub>
, ,	BFFF <sub>H</sub>	7BFFF <sub>H</sub>
SA6 (4 Kbytes)	С000н	7C000н
, , ,	CFFFH	7CFFFн
SA7 (4 Kbytes)		<del>7</del> D000н
	DFFF <sub>H</sub>	7DFFF <sub>H</sub>
SA8 (4 Kbytes)	Е000н	7Е000н
	EFFF <sub>H</sub>	7EFFF <sub>H</sub>
SA9 (4 Kbytes)	F000H	7F000н
	FFFFH	7FFFF <sub>H</sub>

<sup>\* :</sup> Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.

These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

Flash memory	CPU address	Programmer address*
32 Kbytes	8000 <sub>H</sub>	
	FFFFн	7FFFF <sub>H</sub>

These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

#### • Programming Method

- 1) Set the type code of the parallel programmer to "17222".
- 2) Load program data to programmer addresses 78000H to 7FFFFH.
- 3) Programmed by parallel programmer

<sup>\*:</sup> Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.

#### • MB95F114MS/F114NS/F114JS/F114MW/F114NW/F114JW (16 Kbytes)

Flash memory	CPU address	Programmer address*
SA6 (4 Kbytes)	С000н	7С000н
	CFFFH	7CFFF <sub>H</sub>
SA7 (4 Kbytes)	D000н	7D000н
	DFFFH	7DFFF <sub>H</sub>
SA8 (4 Kbytes)	Е000н	7 <u>Е</u> 000н
	EFFFH	7EFFF <sub>H</sub>
SA9 (4 Kbytes)	F000H	7 <u>F</u> 000н
. ,	FFFF <sub>H</sub>	7FFFFн

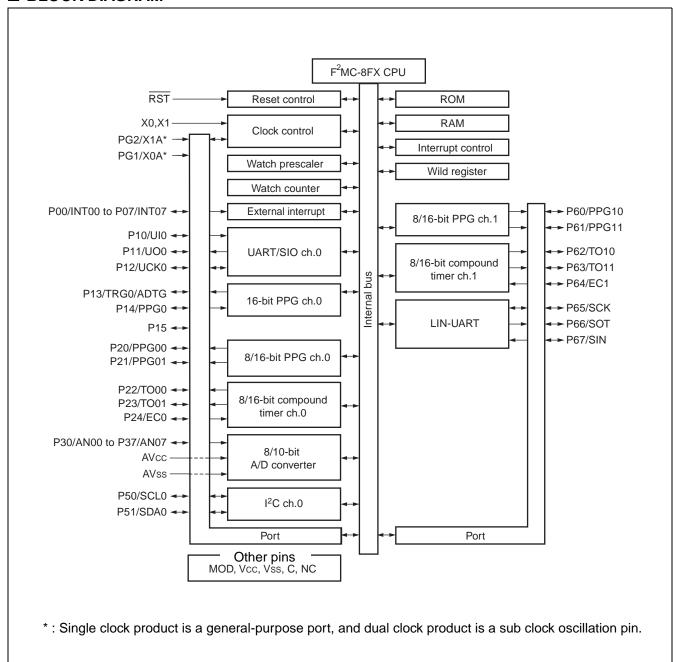
<sup>\*:</sup> Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.

These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

#### • Programming Method

- 1) Set the type code of the parallel programmer to "17222".
- 2) Load program data to programmer addresses 7C000н to 7FFFFн.
- 3) Programmed by parallel programmer

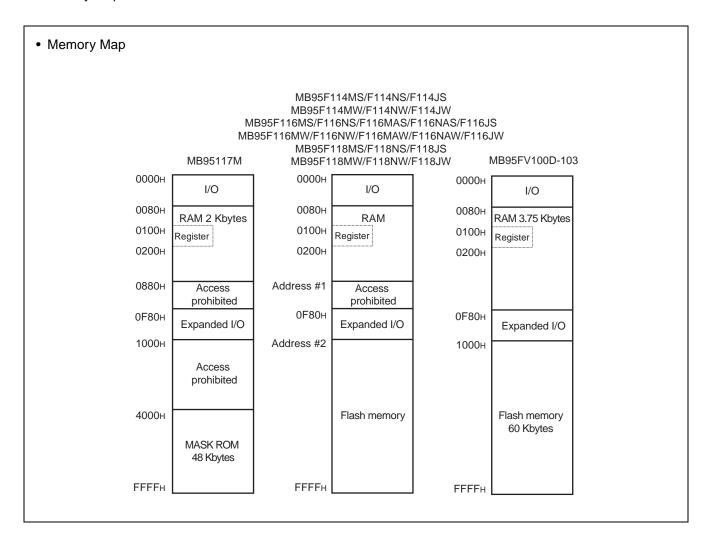
#### **■ BLOCK DIAGRAM**



#### **■ CPU CORE**

#### 1. Memory space

Memory space of the MB95110M series is 64 Kbytes and consists of I/O area, data area, and program area. The memory space includes special-purpose areas such as the general-purpose registers and vector table. Memory map of the MB95110M series is shown below.



	Flash memory	RAM	Address #1	Address #2	
MB95F114MS/F114NS/F114JS	16 Kbytes	512 bytes	0280н	С000н	
MB95F114MW/F114NW/F114JW	10 Kbytes	512 bytes	0280H	Сооон	
MB95F116MS/F116NS/F116JS/ F116MAS/F116NAS	32 Kbytes	1 Kbyte	0480н	8000 <sub>H</sub>	
MB95F116MW/F116NW/F116JW/ F116MAW/F116NAW	32 KDytes	1 Kbyte	U400H	0000h	
MB95F118MS/F118NS/F118JS	60 Kbytes	2 Kbytes	0880⊦	1000⊦	
MB95F118MW/F118NW/F118JW	oo Naytes	2 Noyles	ООООН	1000н	

#### 2. Register

The MB95110M series has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The dedicated registers are as follows:

Program counter (PC) : A 16-bit register to indicate locations where instructions are stored.

Accumulator (A) : A 16-bit register for temporary storage of arithmetic operations. In the case of

an 8-bit data processing instruction, the lower 1 byte is used.

Temporary accumulator (T) : A 16-bit register which performs arithmetic operations with the accumulator.

In the case of an 8-bit data processing instruction, the lower 1 byte is used.

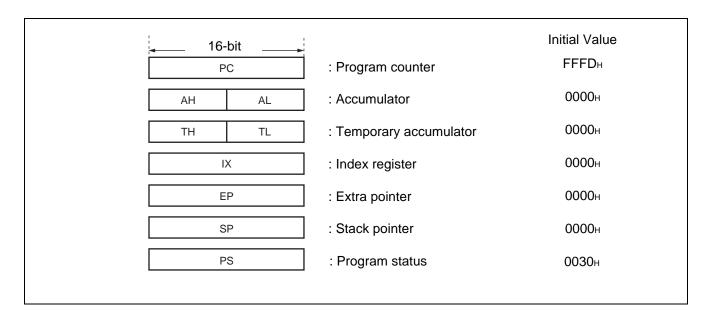
Index register (IX) : A 16-bit register for index modification.

Extra pointer (EP) : A 16-bit pointer to point to a memory address.

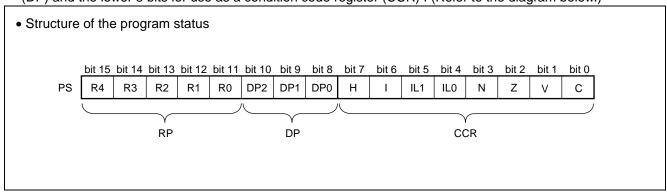
Stack pointer (SP) : A 16-bit register to indicate a stack area.

Program status (PS) : A 16-bit register for storing a register bank pointer, a direct bank pointer, and

a condition code register.



The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and a direct bank pointer (DP) and the lower 8 bits for use as a condition code register (CCR). (Refer to the diagram below.)



The RP indicates the address of the register bank currently being used. The relationship between the content of RP and the real address conforms to the conversion rule illustrated below:

 Rule for Conversion of Actual Addresses in the General-purpose Register Area RP upper OP code lower "0" "1" R4 R3 R2 R1 R0 b2 b0 ¥ ¥ ¥ ¥ ¥ Generated address A<sub>15</sub> A14 A13 A12 A11 A10 Α9 **A8** Α7 A6 A5 Α4 АЗ A2 Α1 A0

The DP specifies the area for mapping instructions (16 different instructions such as MOV A, dir) using direct addresses to 0080<sub>H</sub> to 00FF<sub>H</sub>.

Direct bank pointer (DP2 to DP0)	Specified address area	Mapping area
XXX <sub>B</sub> (no effect to mapping)	0000н to 007Fн	0000н to 007Fн (without mapping)
000 <sub>B</sub> (initial value)		0080н to 00FFн (without mapping)
001в		0100н to 017Fн
010в		0180н to 01FFн
011в	0080н to 00FFн	0200н to 027Fн
100в	— 0000H tO 00FFH	0280н to 02FFн
101в		0300н to 037Fн
110в		0380н to 03FFн
111в		0400н to 047Fн

The CCR consists of the bits indicating arithmetic operation results or transfer data contents and the bits that control CPU operations at interrupt.

H flag : Set to "1" when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation.

Cleared to "0" otherwise. This flag is for decimal adjustment instructions.

I flag : Interrupt is enabled when this flag is set to "1". Interrupt is disabled when this flag is set to "0".

The flag is set to "0" when reset.

IL1, IL0 : Indicates the level of the interrupt currently enabled. Processes an interrupt only if its request level

is higher than the value indicated by these bits.

IL1	IL0	Interrupt level	Priority
0	0	0	High
0	1	1	<b>↑</b>
1	0	2	1
1	1	3	Low ( no interruption)

N flag : Set to "1" if the MSB is set to "1" as the result of an arithmetic operation. Cleared to "0" when the

bit is set to "0".

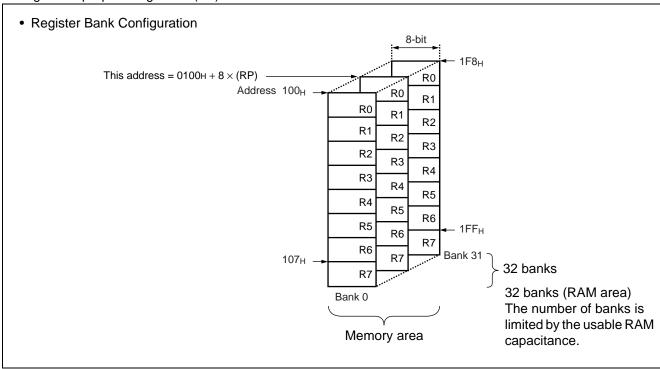
Z flag : Set to "1" when an arithmetic operation results in "0". Cleared to "0" otherwise.

V flag : Set to "1" if the complement on 2 overflows as a result of an arithmetic operation. Cleared to "0" otherwise.

The following general-purpose registers are provided:

General-purpose registers: 8-bit data storage registers

The general-purpose registers are 8 bits and located in the register banks on the memory. 1-bank contains 8-register. Up to a total of 32 banks can be used on the MB95110M series. The bank currently in use is specified by the register bank pointer (RP), and the lower 3 bits of OP code indicates the general-purpose register 0 (R0) to general-purpose register 7 (R7).



### ■ I/O MAP

Address	Register abbreviation	Register name	R/W	Initial value
0000н	PDR0	Port 0 data register	R/W	0000000В
0001н	DDR0	Port 0 direction register	R/W	0000000В
0002н	PDR1	Port 1 data register	R/W	0000000В
0003н	DDR1	Port 1 direction register	R/W	0000000В
0004н	_	(Disabled)		_
0005н	WATR	Oscillation stabilization wait time setting register	R/W	11111111в
0006н	PLLC	PLL control register	R/W	0000000В
0007н	SYCC	System clock control register	R/W	1010X011в
0008н	STBC	Standby control register	R/W	0000000В
0009н	RSRR	Reset source register	R/W	XXXXXXXX
000Ан	TBTC	Time-base timer control register	R/W	0000000в
000Вн	WPCR	Watch prescaler control register	R/W	0000000в
000Сн	WDTC	Watchdog timer control register	R/W	0000000в
000Дн	_	(Disabled)		_
000Ен	PDR2	Port 2 data register	R/W	0000000в
000Fн	DDR2	Port 2 direction register	R/W	0000000в
0010н	PDR3	Port 3 data register	R/W	0000000в
0011н	DDR3	Port 3 direction register	R/W	0000000в
0012н, 0013н	_	(Disabled)	_	_
0014н	PDR5	Port 5 data register	R/W	00000000в
0015н	DDR5	Port 5 direction register	R/W	00000000в
0016н	PDR6	Port 6 data register	R/W	00000000в
0017н	DDR6	Port 6 direction register	R/W	00000000в
0018н to 0029н	_	(Disabled)	_	_
002Ан	PDRG	Port G data register	R/W	0000000В
002Вн	DDRG	Port G direction register	R/W	0000000В
002Сн	_	(Disabled)	_	_
002Dн	PUL1	Port 1 pull-up register	R/W	0000000В
002Ен	PUL2	Port 2 pull-up register	R/W	0000000В
002Fн	PUL3	Port 3 pull-up register	R/W	0000000В
0030н to 0034н	_	(Disabled)	_	_

(Continued)

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Address	Register abbreviation	Register name	R/W	Initial value
0035н	PULG	Port G pull-up register	R/W	0000000В
0036н	T01CR1	8/16-bit compound timer 01 control status register 1 ch.0	R/W	0000000В
0037н	T00CR1	8/16-bit compound timer 00 control status register 1 ch.0	R/W	00000000в
0038н	T11CR1	8/16-bit compound timer 11 control status register 1 ch.1	R/W	00000000в
0039н	T10CR1	8/16-bit compound timer 10 control status register 1 ch.1	R/W	00000000В
003Ан	PC01	8/16-bit PPG1 control register ch.0	R/W	00000000В
003Вн	PC00	8/16-bit PPG0 control register ch.0	R/W	0000000В
003Сн	PC11	8/16-bit PPG1 control register ch.1	R/W	0000000В
003Dн	PC10	8/16-bit PPG0 control register ch.1	R/W	0000000В
003Ен to 0041н	_	(Disabled)		_
0042н	PCNTH0	16-bit PPG status control register (Upper byte) ch.0	R/W	00000000в
0043н	PCNTL0	16-bit PPG status control register (Lower byte) ch.0	R/W	0000000В
0044н to 0047н	_	(Disabled)	_	_
0048н	EIC00	External interrupt circuit control register ch.0/ch.1	R/W	0000000В
0049н	EIC10	External interrupt circuit control register ch.2/ch.3	R/W	0000000В
004Ан	EIC20	External interrupt circuit control register ch.4/ch.5	R/W	0000000В
004Вн	EIC30	External interrupt circuit control register ch.6/ch.7	R/W	0000000В
004Сн to 004Fн	_	(Disabled)	_	_
0050н	SCR	LIN-UART serial control register	R/W	0000000В
0051н	SMR	LIN-UART serial mode register	R/W	0000000В
0052н	SSR	LIN-UART serial status register	R/W	00001000в
0053н	RDR/TDR	LIN-UART reception/transmission data register	R/W	0000000В
0054н	ESCR	LIN-UART extended status control register	R/W	00000100в
0055н	ECCR	LIN-UART extended communication control register	R/W	000000XXB
0056н	SMC10	UART/SIO serial mode control register 1 ch.0	R/W	00000000В
0057н	SMC20	UART/SIO serial mode control register 2 ch.0	R/W	00100000в
0058н	SSR0	UART/SIO serial status register ch.0	R/W	0000001в
0059н	TDR0	UART/SIO serial output data register ch.0	R/W	00000000в
005Ан	RDR0	UART/SIO serial input data register ch.0	R	0000000В
005Вн to 005Fн	_	(Disabled)	_	_

Address	Register abbreviation	Register name	R/W	Initial value
0060н	IBCR00	I <sup>2</sup> C bus control register 0 ch.0	R/W	00000000В
0061н	IBCR10	I <sup>2</sup> C bus control register 1 ch.0	R/W	0000000В
0062н	IBSR0	I <sup>2</sup> C bus status register ch.0	R	0000000В
0063н	IDDR0	I <sup>2</sup> C data register ch.0	R/W	00000000в
0064н	IAAR0	I <sup>2</sup> C address register ch.0	R/W	0000000В
0065н	ICCR0	I <sup>2</sup> C clock control register ch.0	R/W	00000000в
0066н to 006Вн	_	(Disabled)	_	_
006Сн	ADC1	8/10-bit A/D converter control register 1	R/W	0000000В
006Dн	ADC2	8/10-bit A/D converter control register 2	R/W	0000000В
006Ен	ADDH	8/10-bit A/D converter data register (Upper byte)	R/W	0000000В
006Fн	ADDL	8/10-bit A/D converter data register (Lower byte)	R/W	0000000В
0070н	WCSR	Watch counter status register	R/W	0000000В
0071н	_	(Disabled)	_	_
0072н	FSR	Flash memory status register	R/W	000Х0000в
0073н	SWRE0	Flash memory sector writing control register 0	R/W	0000000В
0074н	SWRE1	Flash memory sector writing control register 1	R/W	0000000В
0075н	_	(Disabled)	_	_
0076н	WREN	Wild register address compare enable register	R/W	0000000В
0077н	WROR	Wild register data test setting register	R/W	0000000В
0078н	_	(Mirror of register bank pointer (RP) and direct bank pointer (DP))	_	_
0079н	ILR0	Interrupt level setting register 0	R/W	11111111в
007Ан	ILR1	Interrupt level setting register 1	R/W	111111111
007Вн	ILR2	Interrupt level setting register 2	R/W	11111111в
007Сн	ILR3	Interrupt level setting register 3	R/W	111111111в
007Dн	ILR4	Interrupt level setting register 4	R/W	11111111в
007Ен	ILR5	Interrupt level setting register 5	R/W	111111111
007Fн	_	(Disabled)	_	_
0F80н	WRARH0	Wild register address setting register (Upper byte) ch.0	R/W	0000000В
0F81н	WRARL0	Wild register address setting register (Lower byte) ch.0	R/W	0000000В
0F82н	WRDR0	Wild register data setting register ch.0	R/W	0000000В
0F83н	WRARH1	Wild register address setting register (Upper byte) ch.1	R/W	0000000В
0F84н	WRARL1	Wild register address setting register (Lower byte) ch.1	R/W	0000000В
0F85н	WRDR1	Wild register data setting register ch.1	R/W	0000000В

Address	Register abbreviation	Register name	R/W	Initial value
0F86н	WRARH2	Wild register address setting register (Upper byte) ch.2	R/W	0000000в
0F87н	WRARL2	Wild register address setting register (Lower byte) ch.2	R/W	0000000в
0F88н	WRDR2	Wild register data setting register ch.2	R/W	0000000В
0F89н to 0F91н	_	(Disabled)	_	_
0F92н	T01CR0	8/16-bit compound timer 01 control status register 0 ch.0	R/W	0000000в
0F93н	T00CR0	8/16-bit compound timer 00 control status register 0 ch.0	R/W	0000000В
0F94н	T01DR	8/16-bit compound timer 01 data register ch.0	R/W	00000000В
0F95⊦	T00DR	8/16-bit compound timer 00 data register ch.0	R/W	00000000В
0F96н	TMCR0	8/16-bit compound timer 00/01 timer mode control register ch.0	R/W	0000000В
0F97н	T11CR0	8/16-bit compound timer 11 control status register 0 ch.1	R/W	0000000В
0F98н	T10CR0	8/16-bit compound timer 10 control status register 0 ch.1	R/W	0000000В
0F99⊦	T11DR	8/16-bit compound timer 11 data register ch.1	R/W	00000000В
0F9Aн	T10DR	8/16-bit compound timer 10 data register ch.1	R/W	00000000В
0F9Вн	TMCR1	8/16-bit compound timer 10/11 timer mode control register ch.1	R/W	0000000В
0F9Cн	PPS01	8/16-bit PPG1 cycle setting buffer register ch.0	R/W	11111111в
0F9Dн	PPS00	8/16-bit PPG0 cycle setting buffer register ch.0	R/W	11111111в
0F9Eн	PDS01	8/16-bit PPG1 duty setting buffer register ch.0	R/W	11111111в
0F9Fн	PDS00	8/16-bit PPG0 duty setting buffer register ch.0	R/W	11111111В
0FА0н	PPS11	8/16-bit PPG1 cycle setting buffer register ch.1	R/W	11111111в
0FA1н	PPS10	8/16-bit PPG0 cycle setting buffer register ch.1	R/W	11111111в
0FA2н	PDS11	8/16-bit PPG1 duty setting buffer register ch.1	R/W	11111111в
0FАЗн	PDS10	8/16-bit PPG0 duty setting buffer register ch.1	R/W	11111111в
0FA4н	PPGS	8/16-bit PPG starting register	R/W	0000000В
0FА5н	REVC	8/16-bit PPG output inversion register	R/W	0000000В
0FA6н to 0FA9н	_	(Disabled)	_	_
0FAАн	PDCRH0	16-bit PPG down counter register (Upper byte) ch.0	R	0000000В
0FAВн	PDCRL0	16-bit PPG down counter register (Lower byte) ch.0	R	0000000В
0FАСн	PCSRH0	16-bit PPG cycle setting buffer register (Upper byte) ch.0	R/W	11111111В
0FADн	PCSRL0	16-bit PPG cycle setting buffer register (Lower byte) ch.0	R/W	11111111в
0FAЕн	PDUTH0	16-bit PPG duty setting buffer register (Upper byte) ch.0	R/W	11111111в
0FAFн	PDUTL0	16-bit PPG duty setting buffer register (Lower byte) ch.0	R/W	11111111В

#### (Continued)

Address	Register abbreviation	Register name	R/W	Initial value
0FB0н to 0FBBн	_	(Disabled)	_	_
0FBCн	BGR1	LIN-UART baud rate generator register 1	R/W	0000000В
0FBDн	BGR0	LIN-UART baud rate generator register 0	R/W	0000000В
0FBEн	PSSR0	UART/SIO dedicated baud rate generator prescaler selection register ch.0	R/W	0000000В
0FBFн	BRSR0	UART/SIO dedicated baud rate generator baud rate setting register ch.0	R/W	0000000В
0FC0н to 0FC2н	_	(Disabled)	_	_
0FС3н	AIDRL	A/D input disable register (Lower byte)	R/W	0000000В
0FC4н to 0FE2н	_	(Disabled)	_	_
0FE3н	WCDR	Watch counter data register	R/W	00111111в
0FE4н to 0FE6н	_	(Disabled)	_	_
0FE7н	ILSR2	Input level select register 2	R/W	0000000В
0FE8н, 0FE9н	_	(Disabled)	_	_
0FEAн	CSVCR	Clock supervisor control register	R/W	00011100в
0FEBн to 0FEDн	_	(Disabled)	_	_
0FEEн	ILSR	Input level select register	R/W	0000000В
0FEFн	WICR	Interrupt pin control register	R/W	01000000в
0FF0н to 0FFFн	_	(Disabled)	_	_

#### • R/W access symbols

R/W : Readable/Writable

R : Read only W : Write only

#### • Initial value symbols

0 : The initial value of this bit is "0".1 : The initial value of this bit is "1".

X: The initial value of this bit is undefined.

Note: Do not write to the "(Disabled)". Reading the "(Disabled)" returns an undefined value.

### **■ INTERRUPT SOURCE TABLE**

	Interrupt	Vector tab	le address	Bit name of	Same level
Interrupt source	request number	Upper	Lower	interrupt level setting register	priority order (atsimultaneous occurrence)
External interrupt ch.0	IRQ0	FFFA⊦	FFFB⊦	L00 [1 : 0]	High
External interrupt ch.4	INQU	FFFAH	ГГГОН	L00 [1 . 0]	
External interrupt ch.1	IRQ1	FFF8 <sub>H</sub>	FFF9 <sub>H</sub>	L01 [1 : 0]	
External interrupt ch.5	INQI	ГГГОН	ГГГЭН	L01[1.0]	
External interrupt ch.2	IRQ2	FFF6⊦	FFF7 <sub>H</sub>	L02 [1 : 0]	
External interrupt ch.6	IRQZ	ГГГОН	FFF/H	L02 [1 . 0]	
External interrupt ch.3	IDO2	FFF4		1.02.[4 . 0]	
External interrupt ch.7	IRQ3	FFF4 <sub>H</sub>	FFF5 <sub>H</sub>	L03 [1 : 0]	
UART/SIO ch.0	IRQ4	FFF2 <sub>H</sub>	FFF3 <sub>H</sub>	L04 [1 : 0]	
8/16-bit compound timer ch.0 (Lower)	IRQ5	FFF0⊦	FFF1 <sub>H</sub>	L05 [1:0]	
8/16-bit compound timer ch.0 (Upper)	IRQ6	FFEEH	FFEFH	L06 [1:0]	
LIN-UART (reception)	IRQ7	FFECH	FFEDH	L07 [1:0]	
LIN-UART (transmission)	IRQ8	FFEA⊦	FFEB⊦	L08 [1 : 0]	
8/16-bit PPG ch.1 (Lower)	IRQ9	FFE8 <sub>H</sub>	FFE9⊦	L09 [1 : 0]	
8/16-bit PPG ch.1 (Upper)	IRQ10	FFE6⊦	FFE7 <sub>H</sub>	L10 [1:0]	
(Unused)	IRQ11	FFE4 <sub>H</sub>	FFE5⊦	L11 [1 : 0]	
8/16-bit PPG ch.0 (Upper)	IRQ12	FFE2 <sub>H</sub>	FFE3⊦	L12 [1 : 0]	
8/16-bit PPG ch.0 (Lower)	IRQ13	FFE0 <sub>H</sub>	FFE1 <sub>H</sub>	L13 [1:0]	
8/16-bit compound timer ch.1 (Upper)	IRQ14	FFDEH	FFDF⊦	L14 [1 : 0]	
16-bit PPG ch.0	IRQ15	FFDCH	FFDD⊦	L15 [1 : 0]	
I <sup>2</sup> C ch.0	IRQ16	FFDA <sub>H</sub>	FFDB⊦	L16 [1 : 0]	
(Unused)	IRQ17	FFD8⊦	FFD9⊦	L17 [1:0]	
8/10-bit A/D converter	IRQ18	FFD6⊦	FFD7 <sub>H</sub>	L18 [1 : 0]	
Time-base timer	IRQ19	FFD4 <sub>H</sub>	FFD5 <sub>H</sub>	L19 [1 : 0]	]
Watch prescaler/Watch counter	IRQ20	FFD2 <sub>H</sub>	FFD3 <sub>H</sub>	L20 [1 : 0]	
(Unused)	IRQ21	FFD0⊦	FFD1н	L21 [1 : 0]	
8/16-bit compound timer ch.1 (Lower)	IRQ22	FFCEH	FFCFh	L22 [1 : 0]	▼
Flash memory	IRQ23	FFCCH	FFCDH	L23 [1 : 0]	Low

#### **■ ELECTRICAL CHARACTERISTICS**

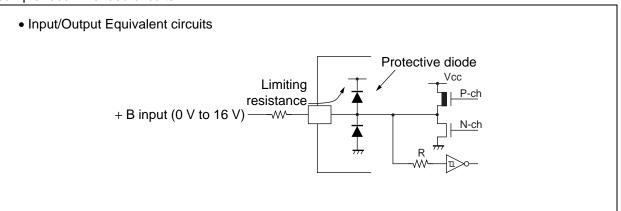
#### 1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Domarko
Parameter	Зунион	Min	Max	Ollit	Remarks
Power supply voltage*1	Vcc AVcc	Vss - 0.3	Vss + 6.0	V	*2
Input voltage*1	Vı	Vss - 0.3	Vss + 6.0	V	*3
Output voltage*1	Vo	Vss - 0.3	Vss + 6.0	V	*3
Maximum clamp current	<b>I</b> CLAMP	- 2.0	+ 2.0	mA	Applicable to pins*4
Total maximum clamp current	$\Sigma  I_CLAMP $	_	20	mA	Applicable to pins*4
"L" level maximum	lo <sub>L1</sub>		15	mA	Other than P00 to P07
output current	lol2	_	15	mA	P00 to P07
"L" level average	lolav1		4	mΛ	Other than P00 to P07 Average output current = operating current × operating ratio (1 pin)
current	Interest average mA locav2 12		IIIA	P00 to P07 Average output current = operating current × operating ratio (1 pin)	
"L" level total maximum output current	$\Sigma$ loL	_	100	mA	
"L" level total average output current	$\Sigma$ lolav	_	50	mA	Total average output current = operating current × operating ratio (Total of pins)
"H" level maximum	<b>І</b> он1		<b>– 15</b>		Other than P00 to P07
output current	10н2	_	<b>– 15</b>	mA	P00 to P07
"H" level average	Іонаv1		- 4	mA	Other than P00 to P07 Average output current = operating current × operating ratio (1 pin)
current	lohav2		- 8	IIIA	P00 to P07 Average output current = operating current × operating ratio (1 pin)
"H" level total maximum output current	ΣІон		- 100	mA	
"H" level total average output current	$\Sigma$ lohav	_	- 50	mA	Total average output current = operating current × operating ratio (Total of pins)

#### (Continued)

Parameter	Symbol	Rat	ing	Unit	Remarks		
raiametei	Symbol	Min	Max	Oilit	Remarks		
Power consumption	Pd	_	320	mW			
Operating temperature	TA	- 40	+ 85	°C			
Storage temperature	Tstg	<b>– 55</b>	+ 150	°C			

- \*1 : The parameter is based on AVss = Vss = 0.0 V.
- \*2 : Apply equal potential to AVcc and Vcc.
- \*3:  $V_1$  and  $V_2$  should not exceed  $V_{CC} + 0.3 V$ .  $V_1$  must not exceed the rating voltage. However, if the maximum current to/from an input is limited by some means with external components, the  $I_{CLAMP}$  rating supersedes the  $V_1$  rating.
- \*4 : Applicable to pins : P00 to P07, P10 to P15, P20 to P24, P30 to P37, P60 to P67
  - Use within recommended operating conditions.
  - Use at DC voltage (current).
  - +B signal is an input signal that exceeds Vcc voltage. The + B signal should always be applied a limiting resistance placed between the + B signal and the microcontroller.
  - The value of the limiting resistance should be set so that when the + B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
  - Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the Vcc pin, and this affects other devices.
  - Note that if the + B signal is inputted when the microcontroller power supply is off (not fixed at 0 V), the power supply is provided from the pins, so that incomplete operation may result.
  - Note that if the + B input is applied during power-on, the power supply is provided from the pins and the resulting power supply voltage may not be sufficient to operate the power-on reset.
  - Care must be taken not to leave the + B input pin open.
  - Sample recommended circuits :



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

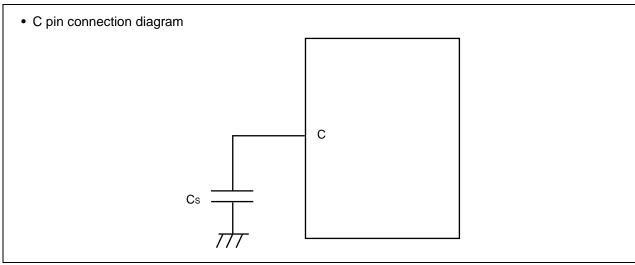
#### 2. Recommended Operating Conditions

(AVss = Vss = 0.0 V)

Parameter	Symbol	Conditions	Value		Unit	Remarks		
Farameter	Syllibol	Conditions	Min	Max	Ollit	Kemarks		
	Vcc, AVcc	_	2.42*1	5.5	V	In normal operation	Other than MB95FV100D-103 MB95FV100D-103	
Power supply voltage			2.3	5.5	V	Hold condition in Stop mode		
			2.7	5.5	V	In normal operation		
			2.3	5.5	V	Hold condition in Stop mode	100D-103	
Smoothing capacitor	Cs		0.1	1.0	μF	*2		
Operating	TA		<b>- 40</b>	+ 85	°C	Other than MB95FV100D-103		
temperature	IA		+ 5	+ 35	°C	MB95FV100D-103		

<sup>\*1:</sup> When the low voltage detection reset is used, reset occurs while the low voltage is detected. For details on the low voltage detection, see "(9) Low Voltage Detection" in "4. AC Characteristics".

<sup>\*2:</sup> Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. A bypass capacitor of Vcc pin must have a capacitance value higher than Cs. For connection of smoothing capacitor Cs, refer to the diagram below.



# WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

#### 3. DC Characteristics

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(Vcc = AVcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, T<sub>A</sub> = - 40 °C to + 85 °C)

Devemeter		D:	Conditions	Value			11:4:4	Damania	
Parameter	Symbol	Pin name	Conditions	Min Typ		Max	Unit	Remarks	
"H" level input voltage	V <sub>IH1</sub>	P10, P67	*1	0.7 Vcc	_	Vcc + 0.3	V	At selecting of CMOS input level	
	V <sub>IH2</sub>	P50, P51	*1	0.7 Vcc	_	Vss + 5.5	V	At selecting of CMOS input level	
	Viha	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P50, P51, P60 to P67, PG1*2, PG2*2	_	0.8 Vcc		Vcc+0.3	V	Pin input at selecting of Automotive input level	
	V <sub>IHS1</sub>	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P60 to P67, PG1*2, PG2*2	*1	0.8 Vcc		Vcc+0.3	V	Hysteresis input	
	V <sub>IHS2</sub>	P50, P51	*1	0.8 Vcc		Vss + 5.5	V	Hysteresis input	
	V <sub>ІНМ</sub>	RST, MOD	_	0.7 Vcc		Vcc + 0.3	V	CMOS input (Flash memory product)	
			_	0.8 Vcc		Vcc + 0.3	V	Hysteresis input (MASK ROM product)	
	VIL	P10, P50, P51, P67	*1	Vss - 0.3	_	0.3 Vcc	V	At selecting of CMOS input level	
"L" level input voltage	Vila	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P50, P51, P60 to P67, PG1*2, PG2*2	_	Vss - 0.3		0.5 Vcc	V	Pin input at selecting of Automotive input level	
	VILS	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P50, P51, P60 to P67, PG1*2, PG2*2	*1	Vss - 0.3	_	0.2 Vcc	V	Hysteresis input	
	VILM	RST, MOD	_	Vss – 0.3		0.3 Vcc	V	CMOS input (Flash memory product)	
			_	Vss - 0.3	_	0.2 Vcc	V	Hysteresis input (MASK ROM product)	

(Vcc = AVcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, T\_A = - 40 °C to + 85 °C)

Damanastan	Symbol	Pin name			Value		11!4	
Parameter			Conditions	Min Typ		Max	Unit	Remarks
Open-drain output application voltage	VD	P50, P51	_	Vss - 0.3	_	Vss + 5.5	V	
"H" level output voltage	Vон1	Output pins other than P00 to P07	Iон = - 4.0 mA	Vcc - 0.5		_	V	
voltage	V <sub>OH2</sub>	P00 to P07	lон = − 8.0 mA	Vcc - 0.5		_	٧	
"L" level output voltage	V <sub>OL1</sub>	Output pins other than P00 to P07	loL = 4.0 mA			0.4	٧	
voltage	V <sub>OL2</sub>	P00 to P07	IoL = 12 mA	_		0.4	٧	
Input leakage current (Hi-Z output leakage current)	lu	Ports other than P50, P51	0.0 V < Vı < Vcc	<b>- 5</b>	_	+ 5	μΑ	When the pull- up prohibition setting
Open-drain output leakage current	ILIOD	P50, P51	0.0 V < V <sub>I</sub> < Vss + 5.5 V	_	_	5	μΑ	
Pull-up resistor	Rpull	P10 to P15, P20 to P24, P30 to P37, PG1*2, PG2*2	V <sub>I</sub> = 0.0 V	25	50	100	kΩ	When the pull- up permission setting
Pull-down resistor	Rмор	MOD	Vı = Vcc	25	50	100	kΩ	MASK ROM product
Input capacitance	Cin	Other than AVcc, AVss, Vcc, Vss	f = 1 MHz	_	5	15	pF	
Power supply current*3	lcc (E	Icc Vcc (External clock operation)	Vcc = 5.5 V FcH = 20 MHz FMP = 10 MHz Main clock mode (divided by 2)	_	9.5	12.5	mA	Flash memory product (at other than Flash memory writing and erasing)
				_	30	35	mA	Flash memory product (at Flash memory writing and erasing)
				_	7.2	9.5	mA	MASK ROM product

(Vcc = AVcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, TA = - 40 °C to + 85 °C)

Dorometer	Symbol	Pin name	Conditions	Value			Unit	Damaadaa
Parameter				Min	Тур	Max	Unit	Remarks
	lcc		Vcc = 5.5 V Fch = 32 MHz FMP = 16 MHz Main clock mode (divided by 2)	_	15.2	20.0	mA	Flash memory product (at other than Flash memory writing and erasing)
					35.7	42.5	mA	Flash memory product (at Flash memory writing and erasing)
					11.6	15.2	mA	MASK ROM product
Power supply current*3	Iccs	Vcc (External clock operation)	Vcc = 5.5 V FcH = 20 MHz FMP = 10 MHz Main sleep mode (divided by 2)	_	4.5	7.5	mA	
			Vcc = 5.5 V Fch = 32 MHz FMP = 16 MHz Main sleep mode (divided by 2)	_	7.2	12.0	mA	
	Iccl		$V_{CC} = 5.5 \text{ V}$ $F_{CL} = 32 \text{ kHz}$ $F_{MPL} = 16 \text{ kHz}$ $Sub \ clock \ mode$ $(divided \ by \ 2) \ ,$ $T_{A} = \ + 25 \ ^{\circ}C$		45	100	μА	
	Iccls		$V_{CC} = 5.5 \text{ V}$ $F_{CL} = 32 \text{ kHz}$ $F_{MPL} = 16 \text{ kHz}$ $Sub \text{ sleep mode}$ $(divided \text{ by 2}),$ $T_{A} = +25 \text{ °C}$	_	10	81	μА	
	Ісст		Vcc = 5.5 V FcL = 32 kHz Watch mode Main stop mode TA = +25 °C		4.6	27	μА	
	Iccmpll		Vcc = 5.5 V FcH = 4 MHz FMP = 10 MHz Main PLL mode (multiplied by 2.5)		9.3	12.5	mA	Flash memory product
				_	7.0	9.5	mA	MASK ROM product
			Vcc = 5.5 V Fch = 6.4 MHz	_	14.9	20.0	mA	Flash memory product
			FMP = 16 MHz Main PLL mode (multiplied by 2.5)	_	11.2	15.2	mA	MASK ROM product



(Continued)

 $(Vcc = AVcc = 5.0 V \pm 10\%, AVss = Vss = 0.0 V, T_A = -40 °C to +85 °C)$ 

Parameter	Sym-	Pin name	Conditions		Value		Unit	Remarks
rarameter	bol	riii iiaiiie	Conditions	Min	Тур	Max	Oilit	Remarks
	Iccspll	Vcc	Vcc = 5.5 V FcL = 32 kHz FMPL = 128 kHz Sub PLL mode (multiplied by 4) TA = +25 °C	ı	160	400	μΑ	(Except MB95F116MA W/F116NAW)
	Істѕ	(External clock operation)	$V_{CC} = 5.5 \text{ V}$ $F_{CH} = 10 \text{ MHz}$ Time-base timer mode $T_A = +25 \text{ °C}$		0.15	1.10	mA	
	Іссн	$V_{CC} = 5.5 \text{ V}$ Sub stop mode $T_A = +25 \text{ °C}$	_	5	20	μΑ	Main stop mode for single clock product	
Power supply current*3	ILVD		Current consumption for low voltage detection circuit only		38	50	μΑ	
	Icsv	Vcc	At oscillating 100 kHz current consumption of built-in CR oscillator		20	36	μΑ	
	la		Vcc = 5.5 V FcH = 16 MHz At operating of A/D conversion	_	2.4	4.7	mA	
	Іан	AVcc	Vcc = 5.5 V FcH = 16 MHz At stopping A/D conversion TA = +25 °C	_	1	5	μΑ	

<sup>\*1:</sup> P10, P50, P51, and P67 can switch the input level to either the "CMOS input level" or "hysteresis input level". The switching of the input level can be set by the input level selection register (ILSR).

<sup>\*2:</sup> Single clock products only

<sup>\*3: •</sup> The power-supply current is determined by the external clock. When both low voltage detection option and clock supervisor are selected, the power-supply current will be a value of adding current consumption of the low voltage detection circuit (ILVD) and current consumption of built-in CR oscillator (ICSV) to the specified value.

<sup>•</sup> Refer to "4. AC Characteristics (1) Clock Timing" for Fch and Fcl.

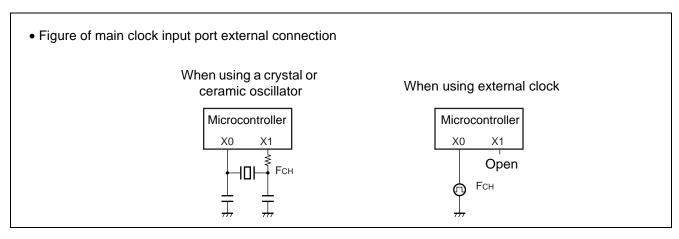
<sup>•</sup> Refer to "4. AC Characteristics (2) Source Clock/Machine Clock" for FMP and FMPL.

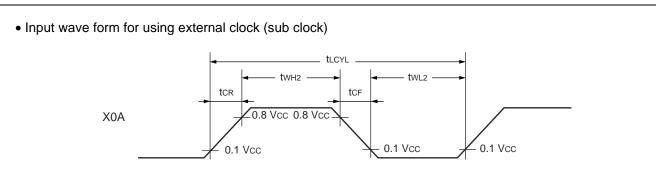
### 4. AC Characteristics

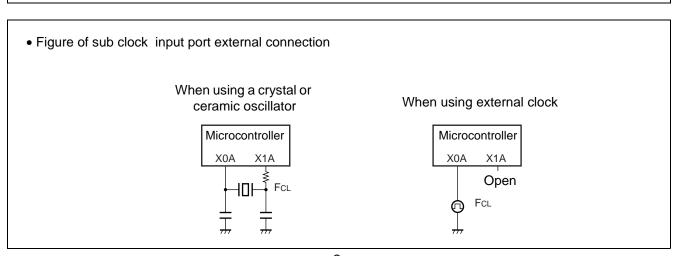
### (1) Clock Timing

(Vcc = 2.42 V to 5.5 V, AVss = Vss = 0.0 V,  $T_A = -40 \, ^{\circ}\text{C}$  to  $+85 \, ^{\circ}\text{C}$ )

Parameter	Sym-	Pin name	Condi-		Value		Unit	Remarks		
Parameter	bol	riii name	tions	Min	Тур	Max	Offic	Remarks		
				1.00		16.25	MHz	When using main oscillation circuit		
				1.00	_	32.50	MHz	When using external clock		
	Fсн	X0, X1		3.00	_	10.00	MHz	Main PLL multiplied by 1		
Clock frequency				3.00	_	8.13	MHz	Main PLL multiplied by 2		
				3.00		6.50	MHz	Main PLL multiplied by 2.5		
				3.00	_	4.06	MHz	Main PLL multiplied by 4		
	FcL				32.768		kHz	When using sub oscillation circuit		
		X0A, X1A	_	_	32.768		kHz	When using sub PLL (Except MB95F116MAW/ F116NAW) Vcc = 2.3 V to 3.6 V		
	<b>t</b> HCYL	X0, X1		61.5		1000	ns	When using main oscillation circuit		
Clock cycle time							30.8	_	1000	ns
	<b>t</b> LCYL	X0A, X1A			30.5		μs	When using sub oscillation circuit		
Input clock pulse width	twh1	X0		61.5			ns	When using external clock Duty ratio is about 30% to		
Input clock pulse width	twH2	X0A			15.2		μs	70%.		
Input clock rise time and fall time	tcr tcr	X0, X0A				5	ns	When using external clock		







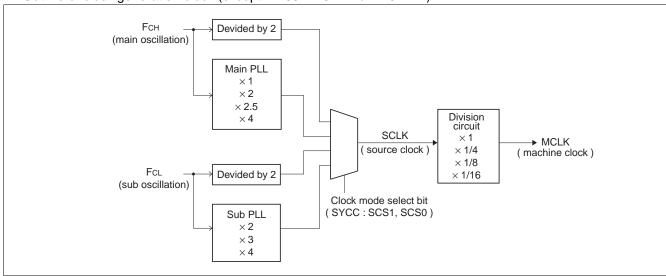
### (2) Source Clock/Machine Clock

 $(Vcc = 5.0 \text{ V} \pm 10\%, \text{ AVss} = \text{Vss} = 0.0 \text{ V}, \text{ T}_{A} = -40 \,^{\circ}\text{C to } +85 \,^{\circ}\text{C})$ 

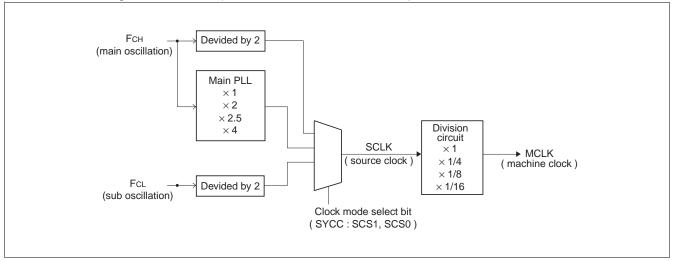
Parameter	Sym-	Condi-		Value		Unit	Remarks
Farameter	bol	tions	Min	Тур	Max	Ollit	Keiliaiks
Source clock cycle time*1	<b>t</b> sclk		61.5	_	2000	ns	When using main clock Min: FcH = 8.125 MHz, PLL multiplied by 2 Max: FcH = 1 MHz, divided by 2
(Clock before setting division)	ISCLK		7.6	_	61.0	μs	When using sub clock Min: FcL = 32 kHz, PLL multiplied by 4 Max: FcL = 32 kHz, divided by 2
Source clock	Fsp		0.50		16.25	MHz	When using main clock
frequency	FSPL		16.384	_	131.072	kHz	When using sub clock
Machine clock cycle time*2 (Minimum	tmclk	_	61.5	_	32000	ns	When using main clock Min: F <sub>SP</sub> = 16.25 MHz, no division Max: F <sub>SP</sub> = 0.5 MHz, divided by 16
instruction execution time)	IMCLK		7.6	_	976.5	μs	When using sub clock Min: F <sub>SPL</sub> = 131 kHz, no division Max: F <sub>SPL</sub> = 16 kHz, divided by 16
Machine clock	<b>F</b> мР		0.031	_	16.250	MHz	When using main clock
frequency	FMPL		1.024	_	131.072	kHz	When using sub clock

- \*1: Clock before setting division due to machine clock division ratio selection bit (SYCC: DIV1 and DIV0). This source clock is divided by the machine clock division ratio selection bit (SYCC: DIV1 and DIV0), and it becomes the machine clock. Further, the source clock can be selected as follows.
  - Main clock divided by 2
  - PLL multiplication of main clock (select from 1, 2, 2.5, 4 multiplication)
  - Sub clock divided by 2
  - PLL multiplication of sub clock (select from 2, 3, 4 multiplication, except MB95F116MAW/F116NAW)
- \*2: Operation clock of the microcontroller. Machine clock can be selected as follows.
  - Source clock (no division)
  - Source clock divided by 4
  - Source clock divided by 8
  - Source clock divided by 16

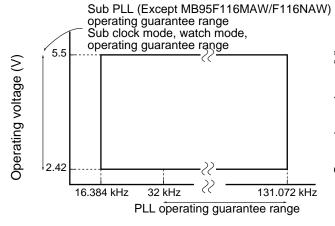
Outline of clock generation block (except MB95F116MAW/F116NAW)



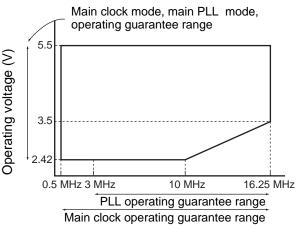
### Outline of clock generation block (For MB95F116MAW/F116NAW)



- Operating voltage Operating frequency ( $T_A = -40 \, ^{\circ}\text{C}$  to  $+85 \, ^{\circ}\text{C}$ )
  - MB95117M/F114MS/F114NS/F114JS/F116MS/F116NS/F116MAS/F116NAS/F116JS/F118MS/F118NS/F118JS/ MB95F114MW/F114NW/F114JW/F116MW/F116NW/F116MAW/F116NAW/F116JW/F118MW/F118 NW/F118JW

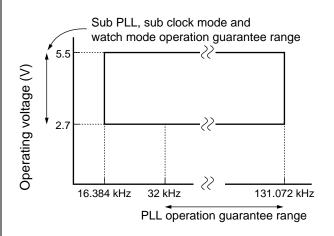


Source clock frequency (FSPL)

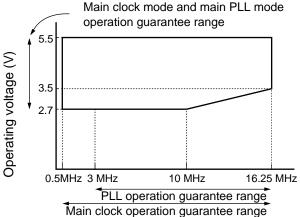


Source clock frequency (Fsp)

- $\bullet$  Operating voltage Operating frequency (TA = + 5  $^{\circ}C$  to + 35  $^{\circ}C)$ 
  - MB95FV100D-103

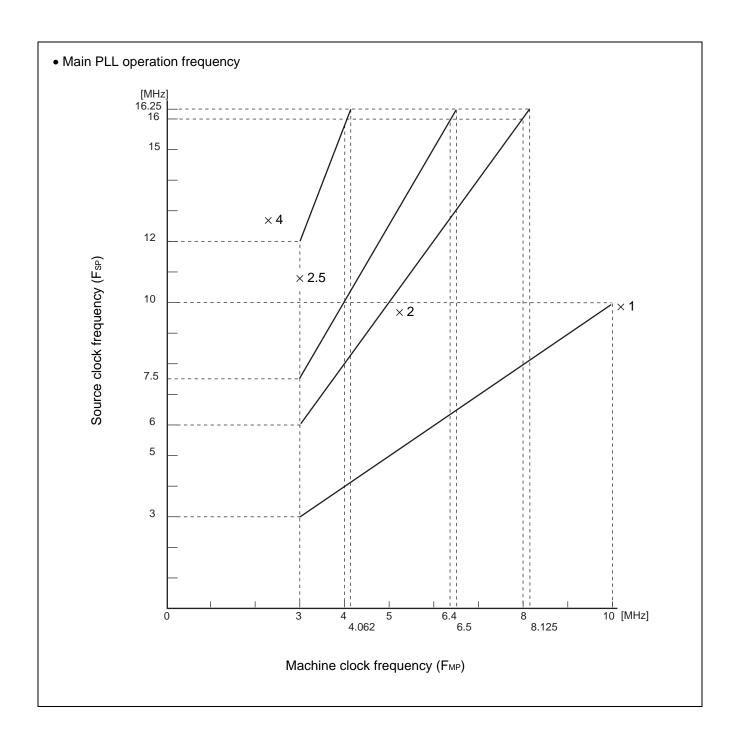


Source clock frequency (FSPL)



Main clock operation guarantee range

Source clock frequency (Fsp)



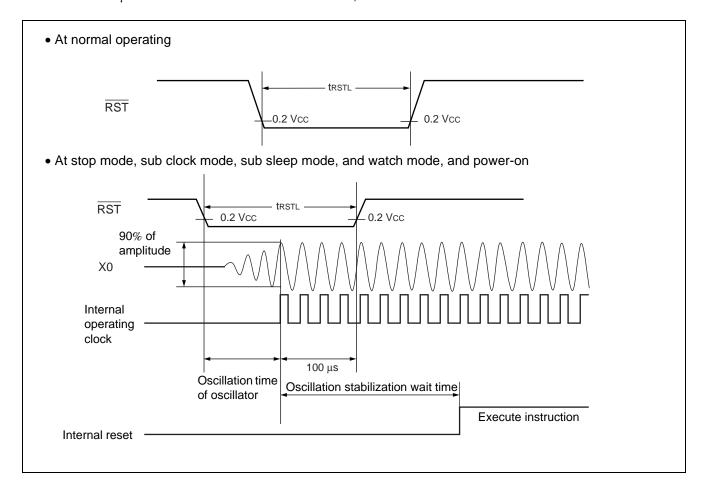
#### (3) External Reset

(Vcc = 5.0 V 
$$\pm$$
 10%, AVss = Vss = 0.0 V, TA =  $-$  40 °C to  $+$  85 °C)

Parameter Symbol	Symbol	Pin	Condi-	Value		Unit	Remarks
	name	tions	Min	Max	Oilit	Kemarks	
RST "L" level pulse width trast.		2 <b>t</b> мclк*1	_	ns	At normal operating		
	RST	_	Oscillation time of oscillator*2 + 100		μs	At stop mode, sub clock mode, sub sleep mode, and watch mode	
				100		μs	At time-base timer mode

<sup>\*1 :</sup> Refer to "(2) Source Clock/Machine Clock" for tmclk.

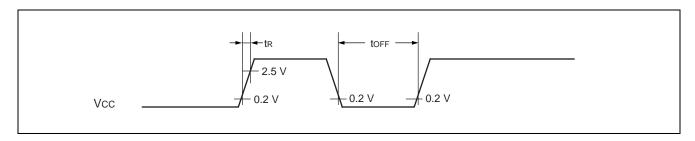
<sup>\*2 :</sup> Oscillation start time of oscillator is the time that the amplitude reaches 90 %. In the crystal oscillator, the oscillation time is between several ms and tens of ms. In ceramic oscillators, the oscillation time is between hundreds of µs and several ms. In the external clock, the oscillation time is 0 ms.



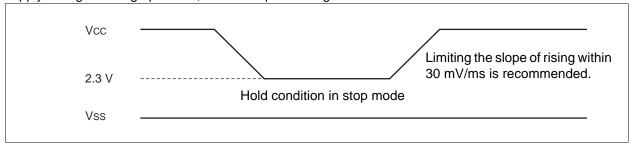
#### (4) Power-on Reset

(AVss = Vss = 0.0 V, 
$$T_A = -40 \, ^{\circ}\text{C}$$
 to  $+85 \, ^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Conditions	Va	lue	Unit	Remarks	
Farameter	Syllibol	name	Conditions	Min	Max	Ollit		
Power supply rising time	<b>t</b> R			_	50	ms		
Power supply cutoff time	toff	Vcc	_	1	_	ms	Waiting time until power-on	



Note: Sudden change of power supply voltage may activate the power-on reset function. When changing power supply voltages during operation, set the slope of rising within 30 mV/ms as shown below.

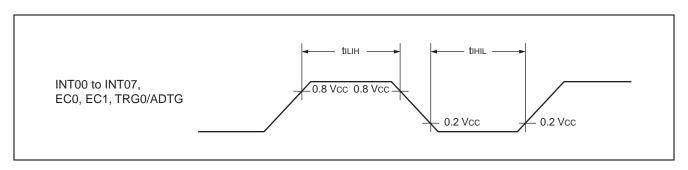


### (5) Peripheral Input Timing

(Vcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, T<sub>A</sub> = -40 °C to +85 °C)

Parameter	Symbol	Condi-	Pin name	Va	Unit	
tions		Fili lialile	Min	Max	Oill	
Peripheral input "H" pulse width	tı∟ıн		INT00 to INT07,	2 tmclk*	_	ns
Peripheral input "L" pulse width	tıнı∟	_	EC0, EC1, TRG0/ADTG	2 tmclk*	_	ns

<sup>\*:</sup> Refer to "(2) Source Clock/Machine Clock" for tmclk.

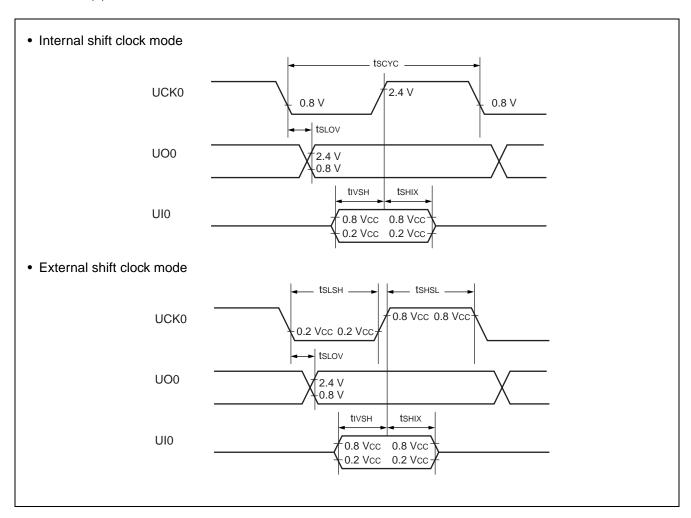


#### (6) UART/SIO, Serial I/O Timing

(Vcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, T<sub>A</sub> = -40 °C to +85 °C)

Parameter	Symbol	Pin name	Conditions	Va	lue	Unit	
raiailletei	Syllibol	riii iiaiii <del>e</del>	Conditions	Min	Max	Oille	
Serial clock cycle time	tscyc	UCK0		<b>4 t</b> мськ*	_	ns	
$UCK\ \downarrow \to UO\ time$	<b>t</b> sLov	UCK0, UO0	Internal clock operation Output pin:	- 190	+ 190	ns	
Valid UI → UCK ↑	tıvsн	UCK0, UI0	C <sub>L</sub> = 80 pF + 1TTL.	<b>2 t</b> мськ*	_	ns	
$UCK \uparrow \to valid \ UI \ hold \ time$	<b>t</b> shix	UCK0, UI0	·	<b>2 t</b> мськ*	_	ns	
Serial clock "H" pulse width	<b>t</b> shsl	UCK0		<b>4 t</b> мськ*	_	ns	
Serial clock "L" pulse width	<b>t</b> slsh	UCK0	External clock operation	<b>4 t</b> мськ*	_	ns	
$UCK\downarrow \to UO$ time	<b>t</b> sLov	UCK0, UO0	Output pin:		190	ns	
Valid UI → UCK ↑	tıvsн	UCK0, UI0	C <sub>L</sub> = 80 pF + 1TTL.	<b>2 t</b> мськ*		ns	
$UCK \uparrow \to valid \; UI \; hold \; time$	<b>t</b> shix	UCK0, UI0		<b>2 t</b> мськ*	_	ns	

<sup>\*:</sup> Refer to "(2) Source Clock/Machine Clock" for tmclk.



#### (7) LIN-UART Timing

Sampling at the rising edge of sampling clock<sup>\*1</sup> and prohibited serial clock delay<sup>\*2</sup>

(ESCR register : SCES bit = 0, ECCR register : SCDE bit = 0)

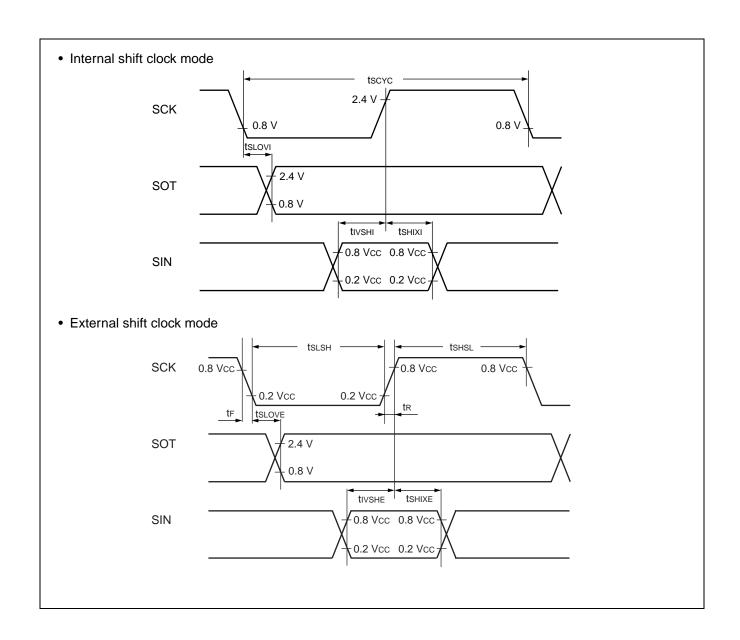
 $(Vcc = 5.0 \text{ V} \pm 10\%, \text{ AVss} = \text{Vss} = 0.0 \text{ V}, \text{ T}_{A} = -40 \,^{\circ}\text{C to } + 85 \,^{\circ}\text{C})$ 

Parameter	Sym-	Pin name	Conditions	Va	lue	Unit	
Farameter	bol	Fill Hallie	Conditions	Min	Max	Oille	
Serial clock cycle time	tscyc	SCK		5 tмськ*3 —		ns	
$SCK \downarrow \to SOT$ delay time	tslovi	SCK, SOT	Internal clock operation output pin:	<b>-95</b>	+ 95	ns	
Valid SIN → SCK ↑	tıvshı	SCK, SIN	C <sub>L</sub> = 80 pF + 1 TTL.	tмськ*3 + 190	_	ns	
$SCK \uparrow \rightarrow valid SIN hold time$	<b>t</b> shixi	SCK, SIN	·	0	_	ns	
Serial clock "L" pulse width	tslsh	SCK		3 tмськ*3 — tR	_	ns	
Serial clock "H" pulse width	tshsl	SCK		tмськ*3 + 95	_	ns	
$SCK \downarrow \to SOT$ delay time	tslove	SCK, SOT	External clock	_	2 tmclk*3 + 95	ns	
Valid SIN → SCK ↑	tivshe	SCK, SIN	operation output pin :	190	_	ns	
$SCK \uparrow \rightarrow valid SIN hold time$	<b>t</b> shixe	SCK, SIN	C <sub>L</sub> = 80 pF + 1 TTL.	tмськ*3 + 95	_	ns	
SCK fall time	t⊧	SCK		_	10	ns	
SCK rise time	<b>t</b> R	SCK			10	ns	

<sup>\*1 :</sup> Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

<sup>\*2 :</sup> Serial clock delay function is used to delay half clock for the output signal of serial clock.

<sup>\*3:</sup> Refer to "(2) Source Clock/Machine Clock" for tmclk.



#### Sampling at the falling edge of sampling clock\*1 and prohibited serial clock delay\*2

(ESCR register : SCES bit = 1, ECCR register : SCDE bit = 0)

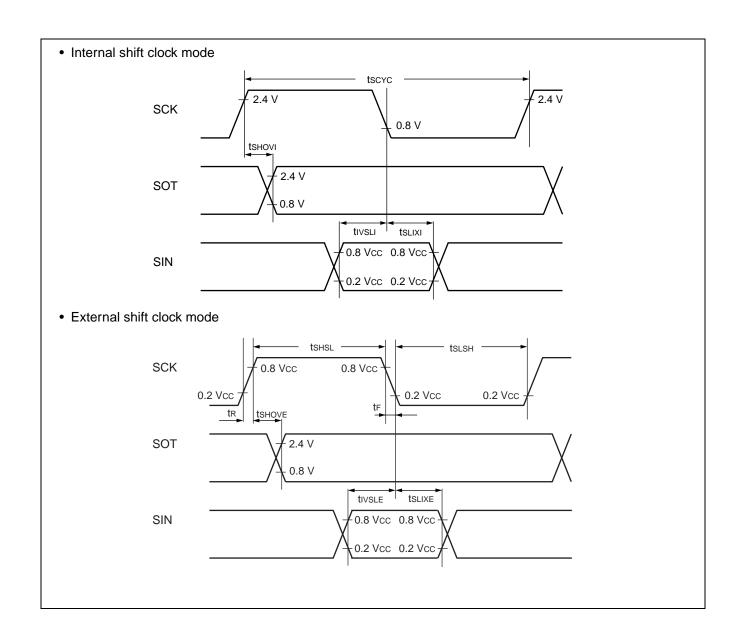
 $(Vcc = 5.0 \text{ V} \pm 10\%, \text{ AVss} = \text{Vss} = 0.0 \text{ V}, \text{ T}_{A} = -40 \,^{\circ}\text{C to } + 85 \,^{\circ}\text{C})$ 

Parameter	Sym-	Pin name	Conditions	Va	lue	Unit	
Parameter	bol	Fin name	Conditions	Min	Max		
Serial clock cycle time	tscyc	SCK		<b>5 t</b> мськ* <sup>3</sup>	_	ns	
$SCK \uparrow \to SOT$ delay time	<b>t</b> shovi	SCK, SOT	Internal clock	-95	+ 95	ns	
Valid SIN → SCK $\downarrow$	<b>t</b> ıvslı	SCK, SIN	operation output pin : C∟ = 80 pF + 1 TTL.	tмськ*3 + 190		ns	
$SCK \downarrow \to valid \; SIN \; hold \; time$	<b>t</b> slixi	SCK, SIN	·	0		ns	
Serial clock "H" pulse width	<b>t</b> shsl	SCK		3 tмськ*3 − tR		ns	
Serial clock "L" pulse width	<b>t</b> slsh	SCK		<b>t</b> мськ*3 + 95	_	ns	
$SCK \uparrow \to SOT$ delay time	<b>t</b> shove	SCK, SOT	External clock	_	2 tmclk*3 + 95	ns	
Valid SIN → SCK $\downarrow$	tivsle	SCK, SIN	operation output pin :	190	_	ns	
$SCK \downarrow \to valid \; SIN \; hold \; time$	<b>t</b> SLIXE	SCK, SIN	C <sub>L</sub> = 80 pF + 1 TTL.	<b>t</b> мськ*3 + 95	_	ns	
SCK fall time	t⊧	SCK		_	10	ns	
SCK rise time	<b>t</b> R	SCK			10	ns	

<sup>\*1 :</sup> Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

<sup>\*2 :</sup> Serial clock delay function is used to delay half clock for the output signal of serial clock.

<sup>\*3:</sup> Refer to "(2) Source Clock/Machine Clock" for tmclk.



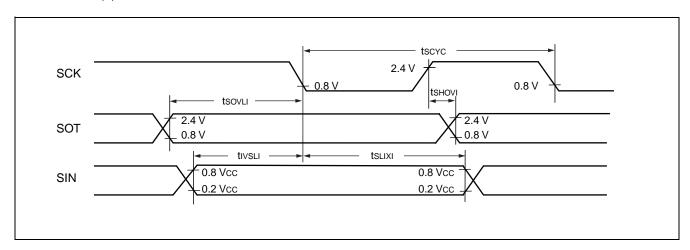
#### Sampling at the rising edge of sampling clock\*1 and enabled serial clock delay\*2

(ESCR register : SCES bit = 0, ECCR register : SCDE bit = 1)

(Vcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, T<sub>A</sub> = -40 °C to +85 °C)

Doromotor	Sym-	Din nome	Conditions	Val	Unit		
Parameter	bol	Pin name	Conditions	Min	Max	Ollit	
Serial clock cycle time	tscyc	SCK		<b>5 t</b> мськ* <sup>3</sup>	_	ns	
$SCK \uparrow \to SOT$ delay time	<b>t</b> shovi	SCK, SOT	Internal clock	-95	+ 95	ns	
Valid SIN $\rightarrow$ SCK $↓$	tıvslı	SCK, SIN	operation output pin :	tмськ*3 + 190		ns	
$SCK \downarrow \rightarrow valid SIN hold time$	<b>t</b> sLIXI	SCK, SIN	$C_L = 80 \text{ pF} + 1 \text{ TTL}.$	0	_	ns	
$SOT \to SCK \downarrow delay\ time$	SCK ↓ delay time tsov⊔ SCK, SOT			_	4 tmclk*3	ns	

- \*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.
- \*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.
- \*3: Refer to "(2) Source Clock/Machine Clock" for tmclk.



#### Sampling at the falling edge of sampling clock<sup>1</sup> and enabled serial clock delay<sup>2</sup>

(ESCR register : SCES bit = 1, ECCR register : SCDE bit = 1)

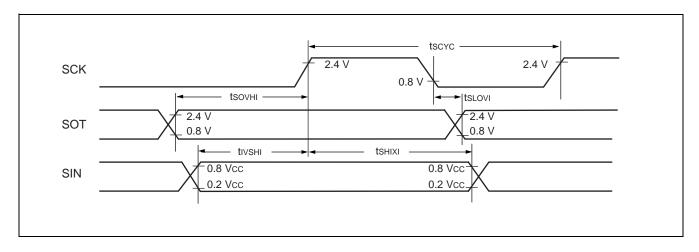
 $(Vcc = 5.0 \text{ V} \pm 10\%, \text{ AVss} = \text{Vss} = 0.0 \text{ V}, \text{ T}_{A} = -40 \text{ }^{\circ}\text{C} \text{ to } + 85 \text{ }^{\circ}\text{C})$ 

Parameter	Sym-	Pin name	Conditions	Valu	Unit	
Parameter	bol	Pili lialile	Conditions	Min	Max	Onit
Serial clock cycle time	tscyc	SCK		<b>5 t</b> мськ* <sup>3</sup>	_	ns
$SCK \downarrow \to SOT$ delay time	tslovi	SCK, SOT	Internal clock	-95	+ 95	ns
Valid SIN → SCK ↑	tıvsнı	SCK, SIN	operating output pin:	tмськ*3 + 190		ns
$SCK \uparrow \to valid \; SIN \; hold \; time$	<b>t</b> shixi	SCK, SIN	$C_L = 80 \text{ pF} + 1 \text{ TTL}.$	0		ns
$SOT \rightarrow SCK \uparrow delay time$	<b>t</b> sovнı	SCK, SOT		_	4 tмськ*3	ns

<sup>\*1 :</sup> Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

\*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

\*3: Refer to " (2) Source Clock/Machine Clock" for tmclk.

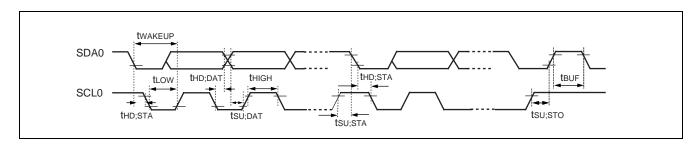


#### (8) I2C Timing

 $(Vcc = 5.0 \text{ V} \pm 10\%, \text{ AVss} = \text{Vss} = 0.0 \text{ V}, \text{ T}_{A} = -40 \,^{\circ}\text{C} \text{ to } +85 \,^{\circ}\text{C})$ 

					Val	ue		
Parameter	Symbol	Pin name	Conditions	Standard mode		Fast mode		Unit
				Min	Max	Min	Max	
SCL clock frequency	fscL	SCL0		0	100	0	400	kHz
(Repeat) Start condition hold time SDA $\downarrow \rightarrow$ SCL $\downarrow$	<b>t</b> hd;sta	SCL0 SDA0		4.0		0.6	_	μs
SCL clock "L" width	<b>t</b> LOW	SCL0	=	4.7	_	1.3	_	μs
SCL clock "H" width	<b>t</b> HIGH	SCL0		4.0	_	0.6	_	μs
(Repeat) Start condition setup time SCL $\uparrow \rightarrow$ SDA $\downarrow$	<b>t</b> su;sta	SCL0 SDA0	$R = 1.7 \text{ k}\Omega,$	4.7		0.6	_	μs
Data hold time SCL $\downarrow$ $\rightarrow$ SDA $\downarrow$ $\uparrow$	thd;dat	SCL0 SDA0	C = 50 pF*1	0	3.45*2	0	0.9*3	μs
Data setup time SDA $\downarrow \uparrow \rightarrow$ SCL $\uparrow$	<b>t</b> su;dat	SCL0 SDA0		0.25		0.1	_	μs
Stop condition setup time SCL $\uparrow \rightarrow$ SDA $\uparrow$	<b>t</b> su;sто	SCL0 SDA0		4		0.6	_	μs
Bus free time between stop condition and start condition	<b>t</b> BUF	SCL0 SDA0		4.7	_	1.3	_	μs

- \*1: R, C: Pull-up resistor and load capacitor of the SCL and SDA lines.
- \*2: The maximum thd; DAT have only to be met if the device dose not stretch the "L" width (tLow) of the SCL signal.
- \*3 : A fast-mode I<sup>2</sup>C-bus device can be used in a standard-mode I<sup>2</sup>C-bus system, but the requirement  $t_{SU;DAT} \ge 250$  ns must then be met.



(Vcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, T\_A = -40  $^{\circ}C$  to  $\,+$  85  $^{\circ}C)$ 

Barray 1	Sym-	Pin	Condi-	Valu	ıe*²		,
Parameter	bol	name	tions	Min	Max	Unit	Remarks
SCL clock "L" width	tLOW	SCL0		(2 + nm / 2) tmclk - 20	_	ns	Master mode
SCL clock "H" width	<b>t</b> HIGH	SCL0		(nm / 2) t <sub>MCLK</sub> - 20	(nm / 2 ) tmcLK + 20	ns	Master mode
Start condition hold time	<b>t</b> HD;STA	SCL0 SDA0		(-1 + nm / 2) tmcLk - 20	(-1 + nm) t <sub>MCLK</sub> + 20	ns	Master mode Maximum value is applied when m, n = 1, 8. Otherwise, the minimum value is applied.
Stop condition setup time	<b>t</b> su;sto	SCL0 SDA0		(1 + nm / 2) tmcLk - 20	(1 + nm / 2) t <sub>MCLK</sub> + 20	ns	Master mode
Start condition setup time	<b>t</b> su;sta	SCL0 SDA0		(1 + nm / 2) tmcLK - 20	(1 + nm / 2) t <sub>MCLK</sub> + 20	ns	Master mode
Bus free time between stop condition and start condition	<b>t</b> BUF	SCL0 SDA0		(2 nm + 4) tmcLK - 20	_	ns	
Data hold time	thd;dat	SCL0 SDA0		3 tmcLK - 20		ns	Master mode
Data setup time	tsu;dat	SCL0 SDA0	$R = 1.7 \text{ k}\Omega$ , $C = 50 \text{ pF}^{*1}$	(-2 + nm / 2) t <sub>MCLK</sub> - 20	(-1 + nm / 2) t <sub>MCLK</sub> + 20	ns	Master mode When assuming that "L" of SCL is not extended, the minimum value is applied to first bit of continuous data. Otherwise, the maximum value is applied.
Setup time between clearing interrupt and SCL rising	tsu;int	SCL0		(nm / 2) t <sub>MCLK</sub> – 20	(1 + nm / 2) tmcLK + 20	ns	Minimum value is applied to interrupt at 9th SCL↓. Maximum value is applied to interrupt at 8th SCL↓.
SCL clock "L" width	tLOW	SCL0		4 tмськ — 20		ns	At reception
SCL clock "H" width	<b>t</b> HIGH	SCL0		4 tmclk - 20	_	ns	At reception
Start condition detection	<b>t</b> hd;sta	SCL0 SDA0		2 tmclk - 20	_	ns	Undetected when 1 tmclk is used at reception
Stop condition detection	<b>t</b> su;sто	SCL0 SDA0		2 tmclk - 20	_	ns	Undetected when 1 tmclk is used at reception
Restart condition detection condition	<b>t</b> su;sta	SCL0 SDA0		2 tmcLK - 20	_	ns	Undetected when 1 tmclk is used at reception
Bus free time	<b>t</b> BUF	SCL0 SDA0		2 tmclk - 20	_	ns	At reception
Data hold time	thd;dat	SCL0 SDA0		2 tмськ — 20	_	ns	At slave transmission mode
Data setup time	<b>t</b> su;dat	SCL0 SDA0		tLow - 3 tMCLK - 20	_	ns	At slave transmission mode

(Continued)

#### (Continued)

$$(Vcc = 5.0 \text{ V} \pm 10\%, \text{ AVss} = \text{Vss} = 0.0 \text{ V}, \text{ T}_{A} = -40 \,^{\circ}\text{C to } + 85 \,^{\circ}\text{C})$$

Parameter	Sym-	Pin	Condi-	Value*2	Unit	Remarks	
raiailletei	bol	name	tions	Min	Max	Oilit	Remarks
Data hold time	<b>t</b> hd;dat	SCL0 SDA0		0	_	ns	At reception
Data setup time	<b>t</b> su;dat		R = 1.7 kΩ, C = 50 pF*1	tмськ — 20	_	ns	At reception
SDA $\downarrow \rightarrow$ SCL $\uparrow$ (at wake-up function)	<b>t</b> WAKEUP	SCL0	о оор.	Oscillation stabilization wait time + 2 tmclk - 20	1	ns	

<sup>\*1 :</sup> R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

- \*2: Refer to "(2) Source Clock/Machine Clock" for tmclk.
  - m is CS4 bit and CS3 bit (bit 4 and bit 3) of clock control register (ICCR0).
  - n is CS2 bit to CS0 bit (bit 2 to bit 0) of clock control register (ICCR0).
  - Actual timing of I<sup>2</sup>C is determined by m and n values set by the machine clock (tmclk) and CS4 to CS0 of ICCR0 register.
  - · Standard-mode:

m and n can be set at the range : 0.9 MHz < tmcLk (machine clock) < 10 MHz.

Setting of m and n limits the machine clock that can be used below.

```
: 0.9 MHz < t<sub>MCLK</sub> ≤ 1 MHz
(m, n) = (1, 8)
(m, n) = (1, 22), (5, 4), (6, 4), (7, 4), (8, 4) : 0.9 \text{ MHz} < t_{MCLK} \le 2 \text{ MHz}
(m,\,n) \; = \; (1,\,38) \; , \; (5,\,8) \; , \; (6,\,8) \; , \; (7,\,8) \; , \; (8,\,8) \quad : 0.9 \; MHz < t_{MCLK} \leq 4 \; MHz \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8) \; , \; (4,\,8)
                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         : 0.9 MHz < t<sub>MCLK</sub> ≤ 10 MHz
(m, n) = (1, 98)
```

• Fast-mode :

m and n can be set at the range : 3.3 MHz < tmcLk (machine clock) < 10 MHz.

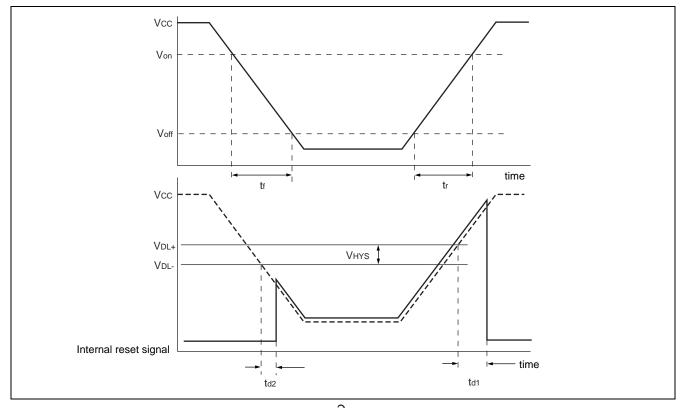
Setting of m and n limits the machine clock that can be used below.

```
: 3.3 MHz < tмсlк ≤ 4 MHz
(m, n) = (1, 8)
(m, n) = (1, 22), (5, 4) : 3.3 \text{ MHz} < t_{MCLK} \le 8 \text{ MHz}
                               : 3.3 \text{ MHz} < t_{\text{MCLK}} \le 10 \text{ MHz}
(m, n) = (6, 4)
```

### (9) Low Voltage Detection

 $(AVss = Vss = 0.0 \text{ V}, T_A = -40 ^{\circ}\text{C to } + 85 ^{\circ}\text{C})$ 

		<u> </u>		Value	(	1		
Parameter	Sym-	Condi-			I	Unit	Remarks	
	bol	tions	Min	Тур	Max			
Release voltage	V <sub>DL+</sub>		2.52	2.70	2.88	V	At power-supply rise	
Detection voltage	V <sub>DL</sub> -		2.42	2.60	2.78	V	At power-supply fall	
Hysteresis width	V <sub>HYS</sub>		70	100	_	mV		
Power-supply start voltage	Voff				2.3	V		
Power-supply end voltage	Von		4.9			V		
Power-supply voltage			0.3		_	μs	Slope of power supply that reset release signal generates	
change time (at power supply rise)	tr	_	_	3000	_	μs	Slope of power supply that reset release signal generates within rating (V <sub>DL+</sub> )	
Power-supply voltage			300		_	μs	Slope of power supply that reset detection signal generates	
change time (at power supply fall)	t <sub>f</sub>		_	300	_	μs	Slope of power supply that reset detection signal generates within rating (V <sub>DL</sub> .)	
Reset release delay time	<b>t</b> d1		_		400	μs		
Reset detection delay time	<b>t</b> d2		_		30	μs		
Current consumption	ILVD		_	38	50	μА	Current consumption for low voltage detection circuit only	



### (10) Clock Supervisor Clock

(Vcc = AVcc = 5.0 V  $\pm$  10%, AVss = Vss = 0.0 V, T\_A = -40 °C to  $\,$  + 85 °C)

Parameter	Symbol	Condi-		Value		Unit	Remarks
Faranietei	Syllibol	tions	Min	Тур	Max	Oilit	Remarks
Oscillation frequency	fоит		50	100	200	kHz	
Oscillation start time	twk		_	_	10	μs	
Current consumption	Icsv	_	_	20	36	μs	Current consumption of built-in CR oscillator, at oscillation of 100 kHz

### 5. A/D Converter

### (1) A/D Converter Electrical Characteristics

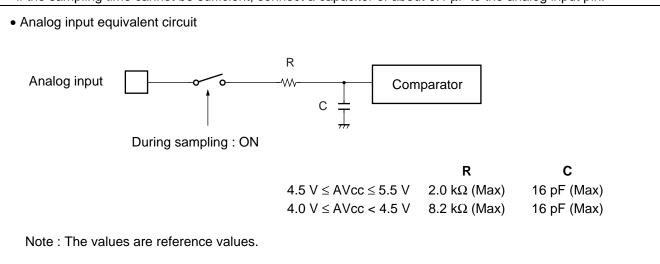
(AVcc = Vcc = 4.0 V to 5.5 V, AVss = Vss = 0.0 V,  $T_A = -40 \, ^{\circ}\text{C}$  to  $+85 \, ^{\circ}\text{C}$ )

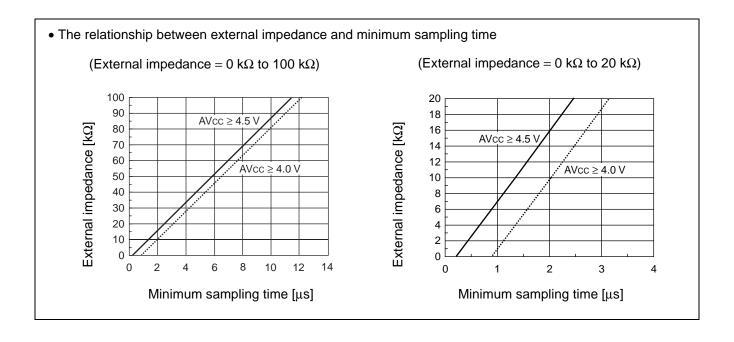
Downston	Sym-	Condi-		Value		Unit	Damarka					
Parameter	bol	tions	Min	Тур	Max	Unit	Remarks					
Resolution			_	_	10	bit						
Total error			- 3.0	_	+ 3.0	LSB						
Linearity error			- 2.5	_	+ 2.5	LSB						
Differential linear error			- 1.9	_	+ 1.9	LSB						
Zero transition voltage	Vот		AVss – 1.5 LSB	AVss + 0.5 LSB	AVss + 2.5 LSB	V						
Full-scale transition voltage	V <sub>FST</sub>		AVcc – 3.5 LSB	AVcc – 1.5 LSB	AVcc + 0.5 LSB	٧						
Compare time			0.9	_	16500	μs	4.5 V ≤ AVcc ≤ 5.5 V					
Compare time			1.8	_	16500	μs	4.0 V ≤ AVcc < 4.5 V					
Campalina tima		_	0.6	_	∞	μs	$4.5 \text{ V} \leq \text{AVcc} \leq 5.5 \text{ V},$ At external impedance < $5.4 \text{ k}\Omega$					
Sampling time	_	_	_					1.2	_	∞	μs	$4.0~V \le AVcc < 4.5~V$ , At external impedance < $2.4~k\Omega$
Analog input current	IAIN		-0.3	_	+ 0.3	μΑ						
Analog input voltage	Vain		AVss	_	AVcc	V						
Reference voltage	_		AVss + 4.0	_	AVcc	V	AVcc pin					
Reference voltage	IR		_	600	900	μΑ	AVcc pin, During A/D operation					
supply current	<b>I</b> RH		_	_	5	μΑ	AVcc pin, At stop mode					

#### (2) Notes on Using A/D Converter

#### . About the external impedance of analog input and its sampling time

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision, Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. Also, if the sampling time cannot be sufficient, connect a capacitor of about  $0.1~\mu F$  to the analog input pin.





#### About errors

As |AVcc - AVss| becomes smaller, values of relative errors grow larger.

#### (3) Definition of A/D Converter Terms

Resolution

The level of analog variation that can be distinguished by the A/D converter.

When the number of bits is 10, analog voltage can be divided into  $2^{10} = 1024$ .

• Linearity error (unit : LSB)

The deviation between the value along a straight line connecting the zero transition point ("00 0000 0000"  $\leftarrow \rightarrow$  "00 0000 0001") of a device and the full-scale transition point

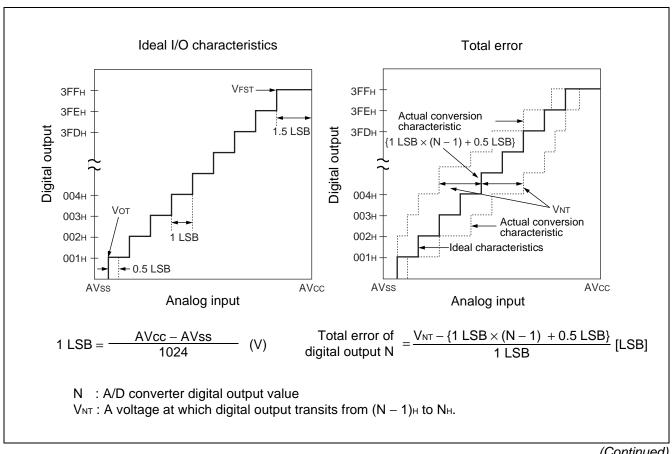
("11 1111 1111"  $\leftarrow$   $\rightarrow$  "11 1111 1110") compared with the actual conversion values obtained.

• Differential linear error (Unit : LSB)

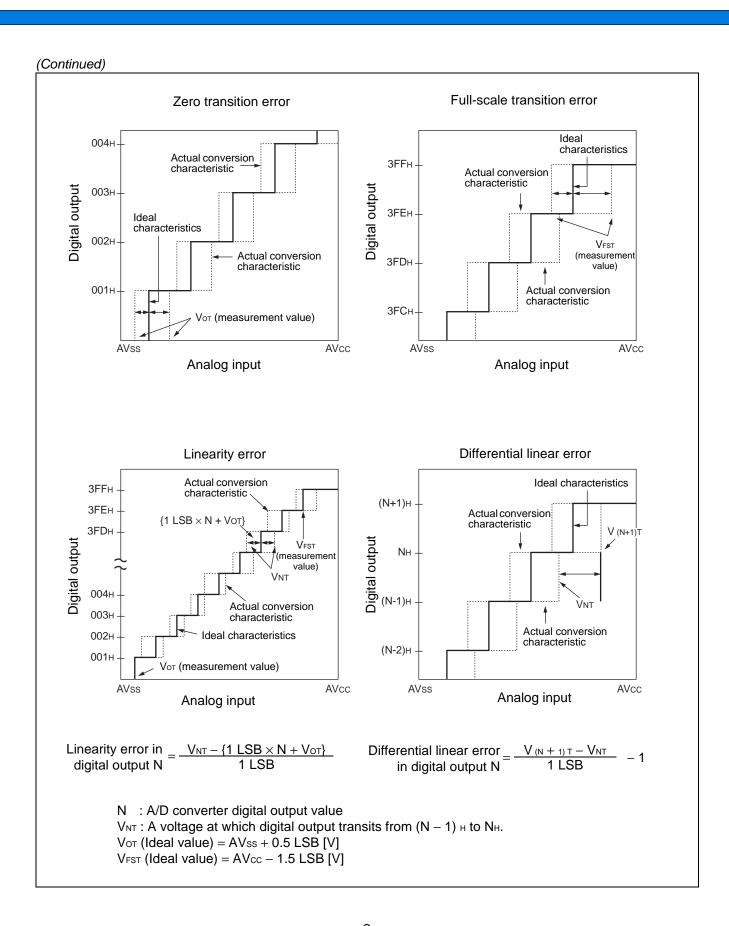
Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.

Total error (unit: LSB)

Difference between actual and theoretical values, caused by a zero transition error, full-scale transition error, linearity error, quantum error, and noise.



(Continued)



#### 6. Flash Memory Program/Erase Characteristics

#### Except MB95F116MAW/F116NAW/F116MAS/F116NAS

Parameter	Condi-	Value			Unit	Remarks
Parameter	tions	Min	Тур	Max	Ullit	Remarks
Sector erase time (4 Kbytes sector)		_	0.2*1	0.5*2	s	Excludes 00 <sub>H</sub> programming prior erasure.
Sector erase time (16 Kbytes sector)			0.5*1	7.5*2	S	Excludes 00 <sub>H</sub> programming prior erasure.
Byte programming time		_	32	3600	μs	Excludes system-level overhead.
Program/erase cycle	_	10000	_	_	cycle	
Power supply voltage at program/erase		4.5	_	5.5	V	
Flash memory data retention time		20*3	_	_	year	Average T <sub>A</sub> = +85 °C

<sup>\*1 :</sup>  $T_A = +25 \, {}^{\circ}C$ ,  $V_{CC} = 5.0 \, V$ , 10000 cycles

#### For MB95F116MAW/F116NAW/F116MAS/F116NAS

Parameter	Condi-	Value			Unit	Remarks	
Parameter	tions	Min	Тур	Max	Onit	Remarks	
Chip erase time		_	1.0*1	15.0*2	s	Excludes 00 <sub>H</sub> programming prior erasure.	
Byte programming time		_	32	3600	μs	Excludes system-level overhead.	
Program/erase cycle	]	10000	_	_	cycle		
Power supply voltage at program/erase		4.5		5.5	V		
Flash memory data retention time		20*3	_	_	year	Average T <sub>A</sub> = +85 °C	

<sup>\*1 :</sup>  $T_A = +25 \, {}^{\circ}C$ ,  $V_{CC} = 5.0 \, V$ , 10000 cycles

<sup>\*2 :</sup>  $T_A = +85 \, ^{\circ}C$ ,  $V_{CC} = 4.5 \, V$ , 10000 cycles

<sup>\*3:</sup> This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at +85 °C).

<sup>\*2 :</sup>  $T_A = +85 \, ^{\circ}C$ ,  $V_{CC} = 4.5 \, V$ , 10000 cycles

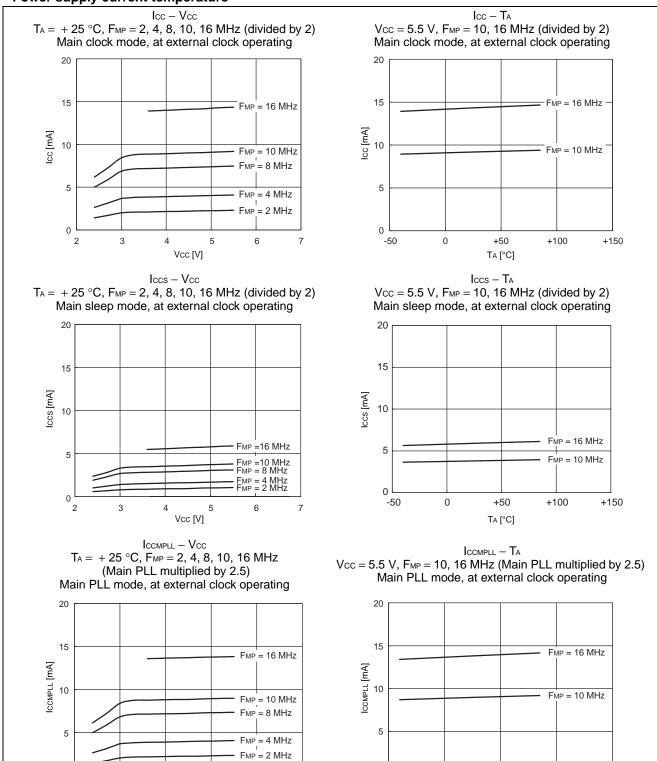
 $<sup>^*3</sup>$ : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at +85  $^{\circ}$ C).

#### **■ EXAMPLE CHARACTERISTICS**

#### Power supply current temperature

0

64



(Continued)

+150

0

+50

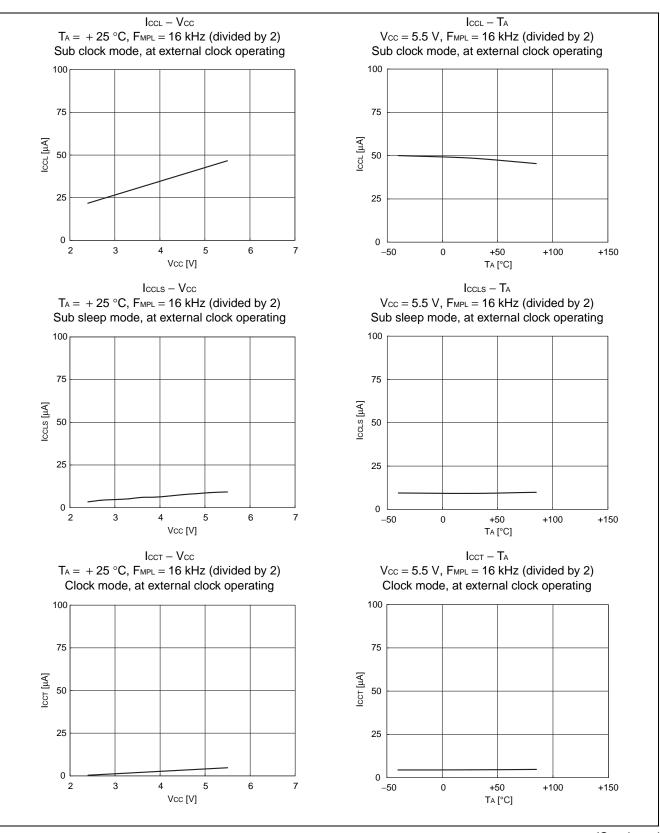
TA [°C]

+100

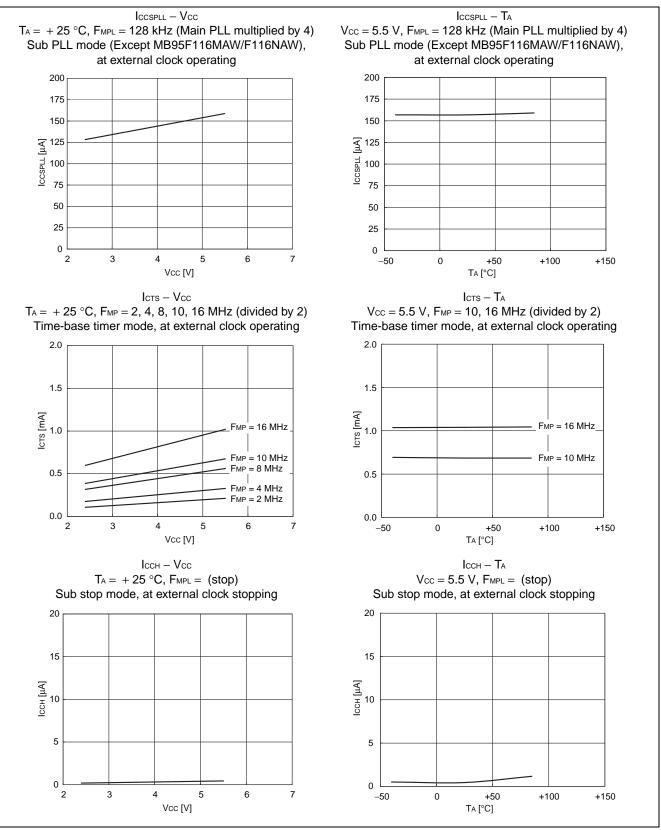
-50

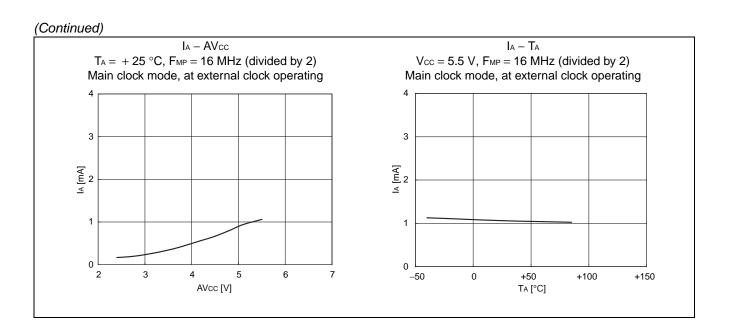
6

Vcc [V]

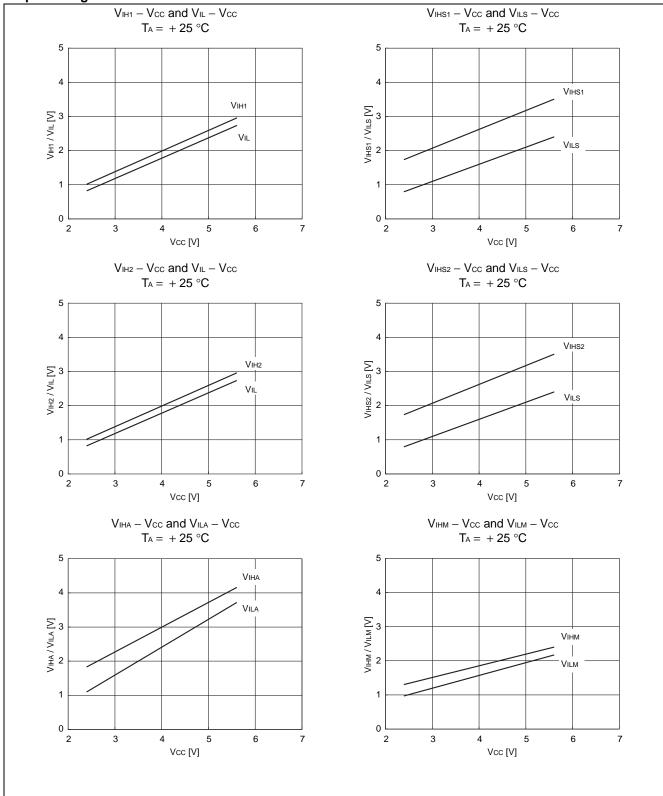


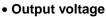
(Continued)

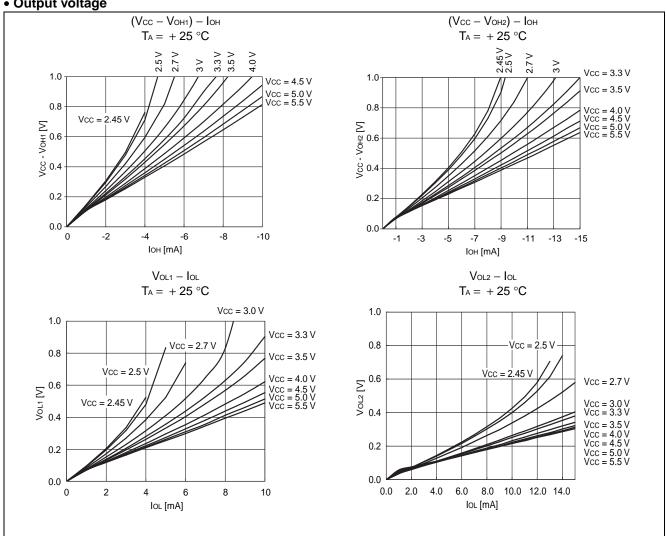




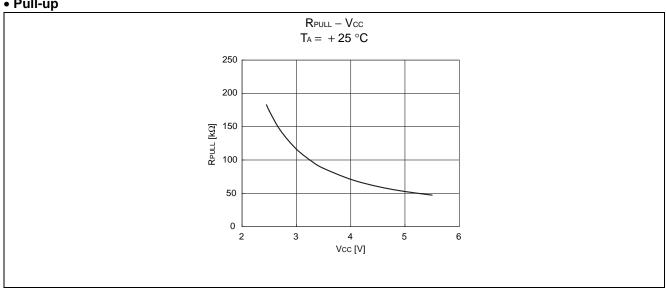








#### • Pull-up



### **■ MASK OPTION**

No.	Part number	MB95117M	MB95F114MS/F114NS MB95F114JS MB95F116MS/F116NS MB95F116MAS/ MB95F116NAS/ MB95F116JS MB95F118MS/F118NS MB95F118JS	MB95F114MW/F114NW MB95F114JW MB95F116MW/F116NW MB95F116MAW/ MB95F116NAW/ MB95F116JW MB95F118MW/F118NW MB95F118JW	MB95FV100D-103
	Specifying procedure	Specify when ordering MASK	Setting disabled	Setting disabled	Setting disabled
1	Clock mode select • Single-system clock mode • Dual-system clock mode	Specify when ordering MASK	Single-system clock mode	Dual-system clock mode	Changing by the switch on MCU board
2	Low voltage detection reset* • With low voltage detection reset • Without low voltage detection reset	Specify when ordering MASK	Specified by part number	Specified by part number	Changing by the switch on MCU board
3	Clock supervisor*  • With clock supervisor  • Without clock supervisor	Specify when ordering MASK	Specified by part number	Specified by part number	Changing by the switch on MCU board
4	Reset output*  • With reset output  • Without reset output	Specify when ordering MASK	Specified by part number	Specified by part number	MCU board switch set as following; • With supervisor: Without reset output • Without supervisor: With reset output
5	Oscillation stabilization wait time	Fixed to oscillation stabiliza- tion wait time of (2 <sup>14</sup> –2) /FcH	Fixed to oscillation stabilization wait time of (2 <sup>14</sup> –2) /FcH	Fixed to oscillation stabilization wait time of (2 <sup>14</sup> –2) /FcH	Fixed to oscillation stabilization wait time of (2 <sup>14</sup> –2) /F <sub>CH</sub>

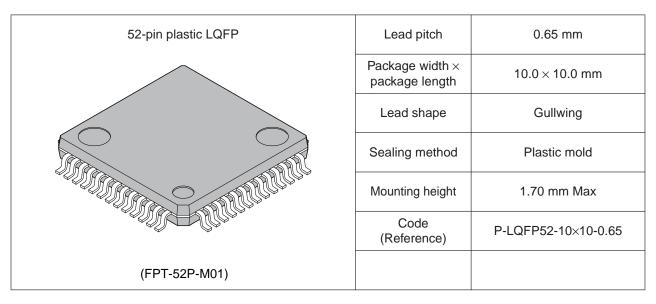
<sup>\*:</sup> Refer to table below about clock mode select, low voltage detection reset, clock supervisor select and reset output.

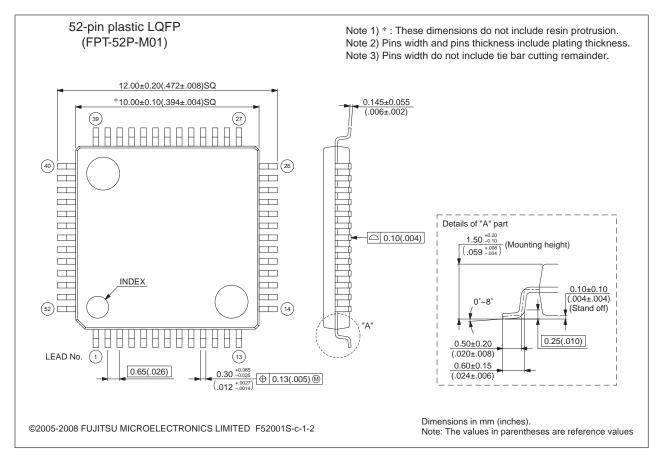
Part number	Clock mode select	Low voltage detection reset	Clock supervisor	Reset output
	Single avetem	No	No	Yes
MB95117M	Single-system	Yes	No	Yes
IVID95117IVI	Dual avetem	No	No	Yes
	Dual-system	Yes	No	Yes
MB95F114MS		No	No	Yes
MB95F114NS		Yes	No	Yes
MB95F114JS	-	Yes	Yes	No
MB95F116MS		No	No	Yes
MB95F116NS	-	Yes	No	Yes
MB95F116MAS	Single-system	No	No	Yes
MB95F116NAS		Yes	No	Yes
MB95F116JS	-	Yes	Yes	No
MB95F118MS	-	No	No	Yes
MB95F118NS		Yes	No	Yes
MB95F118JS		Yes	Yes	No
MB95F114MW		No	No	Yes
MB95F114NW	-	Yes	No	Yes
MB95F114JW	-	Yes	Yes	No
MB95F116MW		No	No	Yes
MB95F116NW	-	Yes	No	Yes
MB95F116MAW	Dual-system	No	No	Yes
MB95F116NAW		Yes	No	Yes
MB95F116JW	-	Yes	Yes	No
MB95F118MW	-	No	No	Yes
MB95F118NW	1	Yes	No	Yes
MB95F118JW	1	Yes	Yes	No
		No	No	Yes
	Single-system	Yes	No	Yes
MB95FV100D-103		Yes	Yes	No
MD30L A 100D-103		No	No	Yes
	Dual-system	Yes	No	Yes
		Yes	Yes	No

### **■** ORDERING INFORMATION

Part number	Package
MB95117MPMC MB95F114MSPMC MB95F114JSPMC MB95F116MSPMC MB95F116NSPMC MB95F116NASPMC MB95F116NASPMC MB95F116JSPMC MB95F118MSPMC MB95F118MSPMC MB95F118JSPMC MB95F114MWPMC MB95F114MWPMC MB95F114JWPMC MB95F116MWPMC MB95F118JWPMC MB95F118MWPMC MB95F118MWPMC MB95F118NWPMC MB95F118NWPMC MB95F118NWPMC	52-pin plastic LQFP (FPT-52P-M01)
MB2146-303A-E (MB95FV100D-103PBT)	MCU board (224-pin plastic PFBGA) (BGA-224P-M08)

#### **■ PACKAGE DIMENSION**



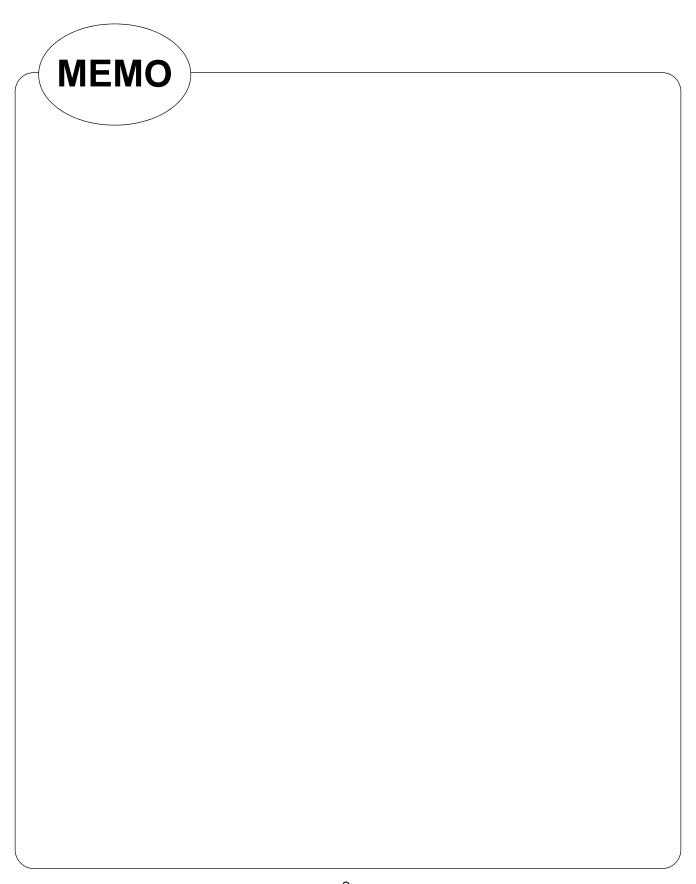


Please confirm the latest Package dimension by following URL. http://edevice.fujitsu.com/package/en-search/

### ■ MAIN CHANGES IN THIS EDITION

Page	Section	Change Results
5	■ PRODUCT LINEUP	Changed the Note. (MB2146-303A → MB2146-303A-E)
14	■ HANDLING DEVICES	Added the item of " Serial communication".
33	■ ELECTRICAL CHARACTERISTICS 2. Recommended Operating Conditions	Changed *1 under the table.
72	■ ORDERING INFORMATION	Changed the part number. (MB2146-303A → MB2146-303A-E)

The vertical lines marked in the left side of the page show the changes.



### **FUJITSU MICROELECTRONICS LIMITED**

Shinjuku Dai-Ichi Seimei Bldg., 7-1, Nishishinjuku 2-chome, Shinjuku-ku, Tokyo 163-0722, Japan

Tel: +81-3-5322-3347 Fax: +81-3-5322-3387

http://jp.fujitsu.com/fml/en/

For further information please contact:

#### **North and South America**

http://www.fma.fujitsu.com/

FUJITSU MICROELECTRONICS AMERICA, INC. 1250 E. Arques Avenue, M/S 333 Sunnyvale, CA 94085-5401, U.S.A. Tel: +1-408-737-5600 Fax: +1-408-737-5999

#### **Europe**

FUJITSU MICROELECTRONICS EUROPE GmbH Pittlerstrasse 47, 63225 Langen, Germany Tel: +49-6103-690-0 Fax: +49-6103-690-122 http://emea.fujitsu.com/microelectronics/

#### Korea

FUJITSU MICROELECTRONICS KOREA LTD. 206 Kosmo Tower Building, 1002 Daechi-Dong, Gangnam-Gu, Seoul 135-280, Republic of Korea Tel: +82-2-3484-7100 Fax: +82-2-3484-7111 http://kr.fujitsu.com/fmk/

#### **Asia Pacific**

FUJITSU MICROELECTRONICS ASIA PTE. LTD. 151 Lorong Chuan, #05-08 New Tech Park 556741 Singapore Tel: +65-6281-0770 Fax: +65-6281-0220 http://www.fmal.fujitsu.com/

FUJITSU MICROELECTRONICS SHANGHAI CO., LTD. Rm. 3102, Bund Center, No.222 Yan An Road (E), Shanghai 200002, China Tel: +86-21-6146-3688 Fax: +86-21-6335-1605

http://cn.fujitsu.com/fmc/

FUJITSU MICROELECTRONICS PACIFIC ASIA LTD. 10/F., World Commerce Centre, 11 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: +852-2377-0226 Fax: +852-2376-3269

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